

To all our customers

Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp.

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note : Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

3806 Group

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

DESCRIPTION

The 3806 group is 8-bit microcomputer based on the 740 family core technology.

The 3806 group is designed for controlling systems that require analog signal processing and include two serial I/O functions, A-D converters, and D-A converters.

The various microcomputers in the 3806 group include variations of internal memory size and packaging. For details, refer to the section on part numbering.

For details on availability of microcomputers in the 3806 group, refer to the section on group expansion.

FEATURES

- Basic machine-language instructions 71
- Memory size
 - ROM 12 K to 48 K bytes
 - RAM 384 to 1024 bytes
- Programmable input/output ports 72
- Interrupts 16 sources, 16 vectors
- Timers 8 bit × 4
- Serial I/O1 8-bit × 1 (UART or Clock-synchronized)
- Serial I/O2 8-bit × 1 (Clock-synchronized)
- A-D converter 8-bit × 8 channels
- D-A converter 8-bit × 2 channels

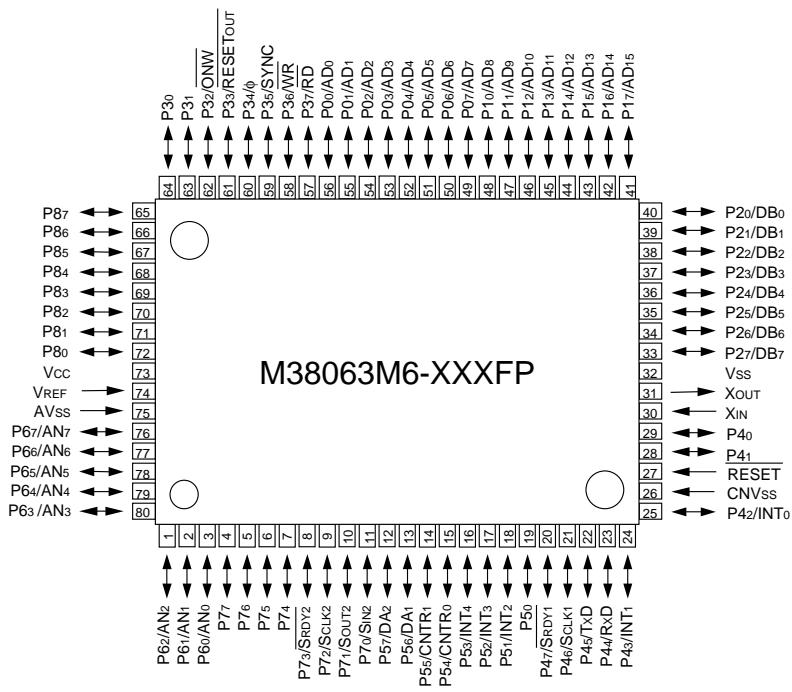
- Clock generating circuit Internal feedback resistor
(connect to external ceramic resonator or quartz-crystal)
- Memory expansion possible

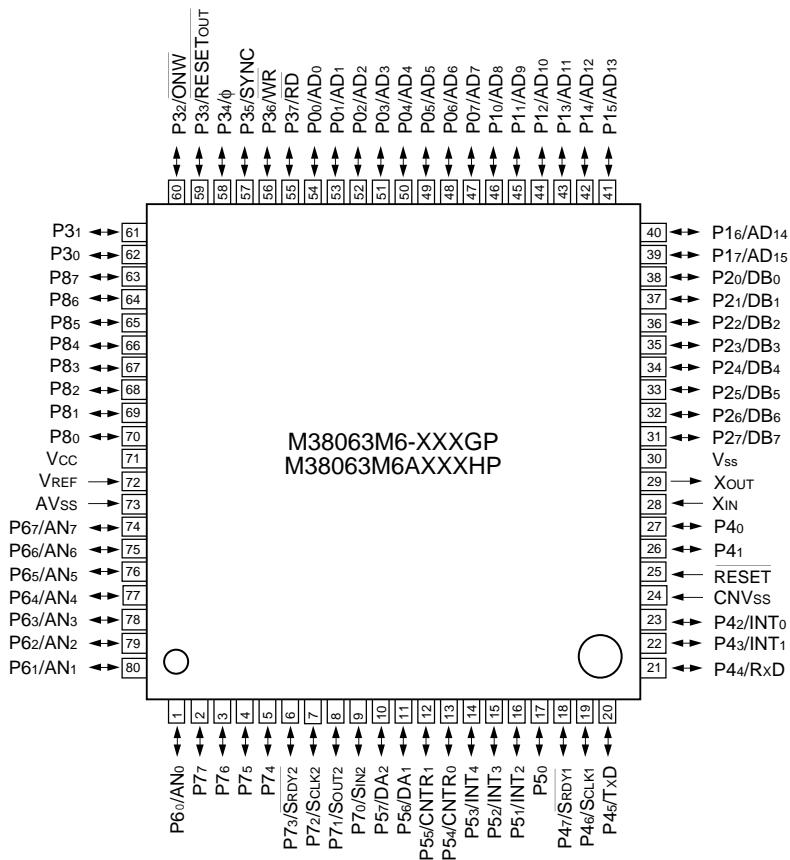
Specification (unit)	Standard	Extended operating temperature version	High-speed version
Minimum instruction execution time (μs)	0.5	0.5	0.4
Oscillation frequency (MHz)	8	8	10
Power source voltage (V)	3.0 to 5.5	4.0 to 5.5	2.7 to 5.5
Power dissipation (mW)	32	32	40
Operating temperature range (°C)	-20 to 85	-40 to 85	-20 to 85

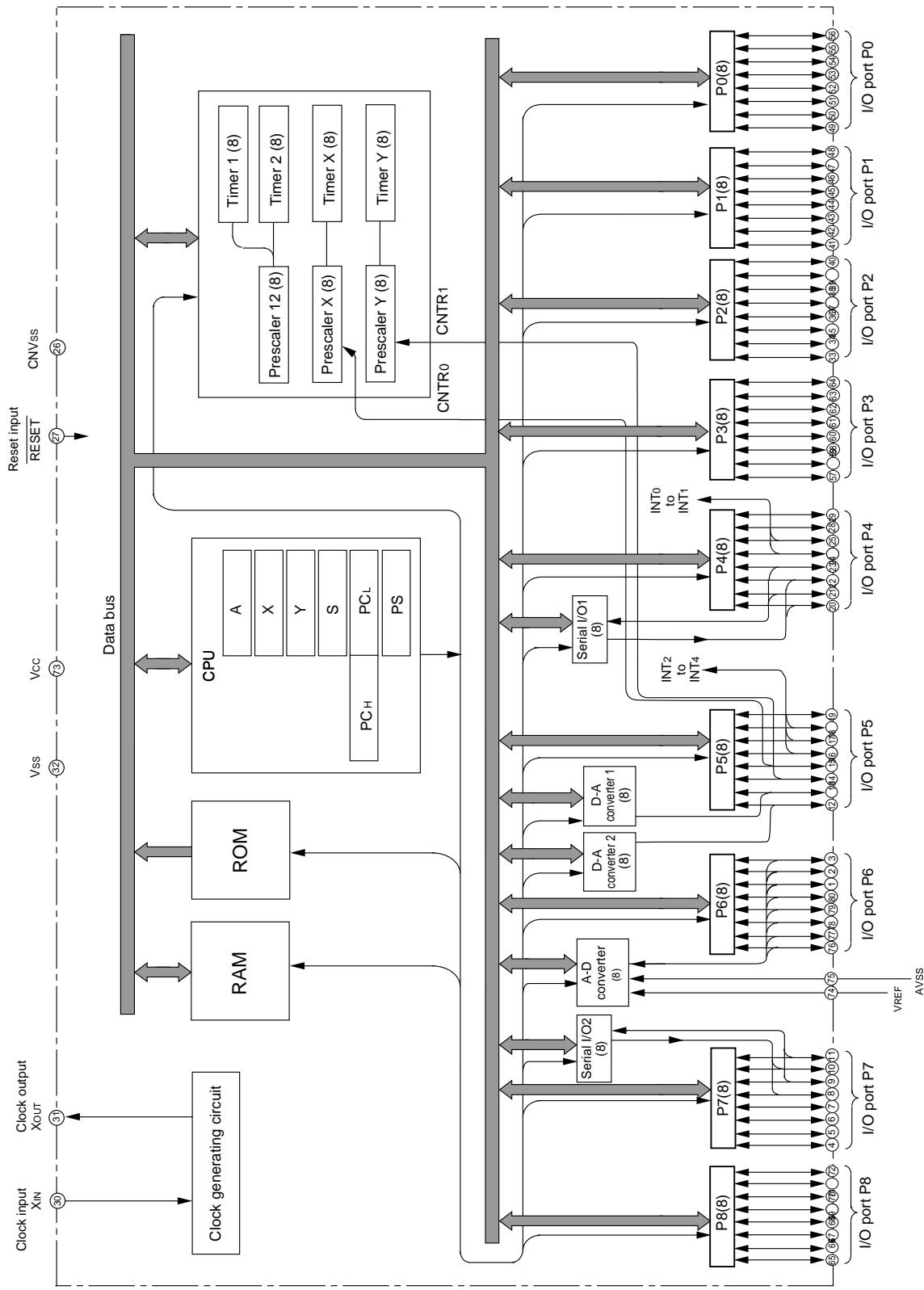
APPLICATIONS

Office automation, VCRs, tuners, musical instruments, cameras, air conditioners, etc.

PIN CONFIGURATION (TOP VIEW)



PIN CONFIGURATION (TOP VIEW)

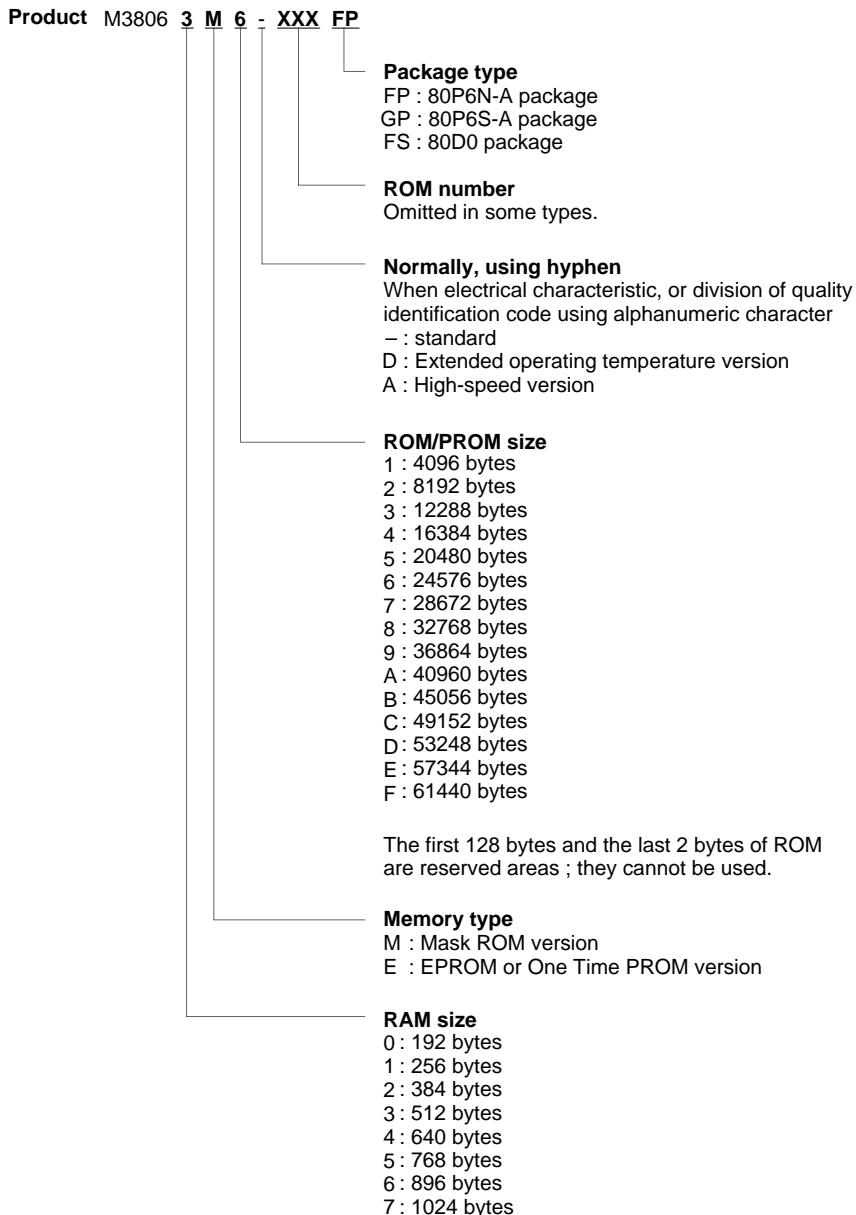
FUNCTIONAL BLOCK DIAGRAM (Package : 80P6N)

PIN DESCRIPTION

Pin	Name	Function	Function except a port function
Vcc	Power source	• Apply voltage of 3.0 V to 5.5 V to Vcc, and 0 V to Vss. (Extended operating temperature version : 4.0 V to 5.5 V) (High-speed version : 2.7 V to 5.5 V)	
Vss			
CNVss	CNVss	• This pin controls the operation mode of the chip. • Normally connected to Vss. • If this pin is connected to Vcc, the internal ROM is inhibited and external memory is accessed.	
VREF	Analog reference voltage	• Reference voltage input pin for A-D and D-A converters	
AVss	Analog power source	• GND input pin for A-D and D-A converters • Connect to Vss.	
RESET	Reset input	• Reset input pin for active "L"	
XIN	Clock input	• Input and output signals for the internal clock generating circuit. • Connect a ceramic resonator or quartz-crystal oscillator between the XIN and XOUT pins to set the oscillation frequency.	
XOUT	Clock output	• If an external clock is used, connect the clock source to the XIN pin and leave the XOUT pin open. • The clock is used as the oscillating source of system clock.	
P00 – P07	I/O port P0	• 8 bit CMOS I/O port	
P10 – P17	I/O port P1	• I/O direction register allows each pin to be individually programmed as either input or output. • At reset this port is set to input mode.	
P20 – P27	I/O port P2	• In modes other than single-chip, these pins are used as address, data, and control bus I/O pins. • CMOS compatible input level	
P30 – P37	I/O port P3	• CMOS 3-state output structure	
P40, P41	I/O port P4	• 8-bit CMOS I/O port with the same function as port P0 • CMOS compatible input level • CMOS 3-state output structure	• External interrupt input pin
P42/INT0, P43/INT1			• Serial I/O1 I/O pins
P44/RxD, P45/TxD, P46/SCLK1, P47/SDRDY1			
P50	I/O port P5	• 8-bit CMOS I/O port with the same function as port P0 • CMOS compatible input level • CMOS 3-state output structure	• External interrupt input pin
P51/INT2 – P53/INT4			• Timer X and Timer Y I/O pins
P54/CNTR0, P55/CNTR1			• D-A conversion output pins
P56/DA1, P57/DA2			
P60/AN0 – P67/AN7	I/O port P6	• 8-bit CMOS I/O port with the same function as port P0 • CMOS compatible input level • CMOS 3-state output structure	• A-D conversion input pins

PIN DESCRIPTION (Continued)

Pin	Name	Function	Function except a port function
P70/SIN2, P71/SOUT2, P72/SCLK2, P73/SDRDY2	I/O port P7	<ul style="list-style-type: none"> • 8-bit I/O port with the same function as port P0 • CMOS compatible input level • N-channel open-drain output structure 	<ul style="list-style-type: none"> • Serial I/O2 I/O pins
P74 – P77			
P80 – P87	I/O port P8	<ul style="list-style-type: none"> • 8-bit CMOS I/O port with the same function as port P0 • CMOS compatible input level • CMOS 3-state output structure 	

PART NUMBERING

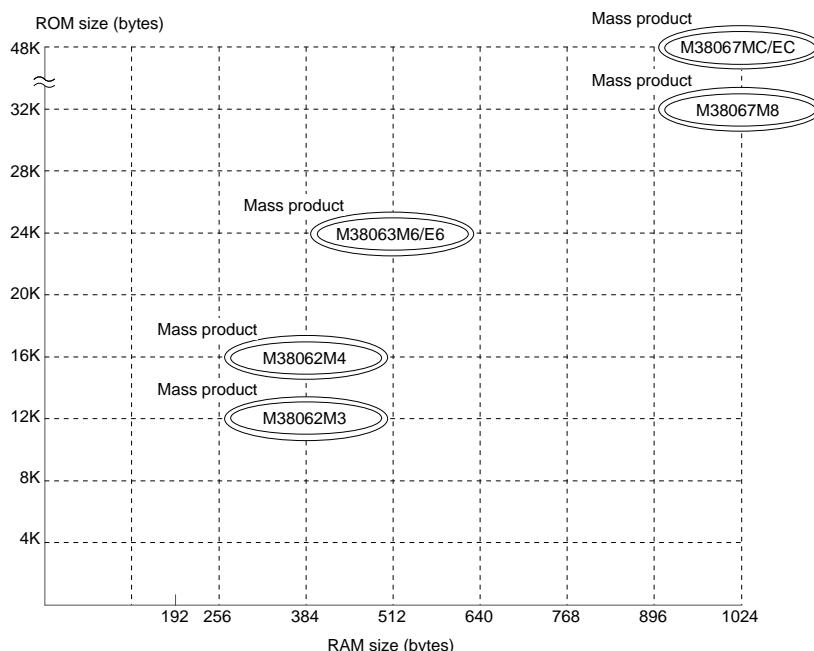
GROUP EXPANSION

Mitsubishi plans to expand the 3806 group as follows:

- (1) Support for mask ROM, One Time PROM, and EPROM versions
- | | |
|-------------------------|--------------------|
| ROM/PROM capacity | 12 K to 48 K bytes |
| RAM capacity | 384 to 1024 bytes |

(2) Packages

- | | |
|---------------|--|
| 80P6N-A | 0.8 mm-pitch plastic molded QFP |
| 80P6S-A | 0.65 mm-pitch plastic molded QFP |
| 80D0 | 0.8 mm-pitch ceramic LCC (EPROM version) |

Memory Expansion Plan

Products under development : the development schedule and specification may be revised without notice.

Currently supported products are listed below**As of May 1996**

Product name	(P) ROM size (bytes) ROM size for User in ()	RAM size (bytes)	Package	Remarks
M38062M3-XXXFP	12288 (12158)	384	80P6N-A	Mask ROM version
M38062M3-XXXGP			80P6S-A	Mask ROM version
M38062M4-XXXFP	16384 (16254)	384	80P6N-A	Mask ROM version
M38062M4-XXXGP			80P6S-A	Mask ROM version
M38063M6-XXXFP	24576 (24446)	512	80P6N-A	Mask ROM version
M38063E6-XXXFP			80P6N-A	One Time PROM version
M38063E6FP			80P6N-A	One Time PROM version (blank)
M38063M6-XXXGP			80P6S-A	Mask ROM version
M38063E6-XXXGP			80P6S-A	One Time PROM version
M38063E6GP			80P6S-A	One Time PROM version (blank)
M38063E6FS			80D0	EPROM version
M38067M8-XXXFP	32768 (32638)	1024	80P6N-A	Mask ROM version
M38067M8-XXXGP			80P6S-A	Mask ROM version
M38067MC-XXXFP	49152 (49022)	1024	80P6N-A	Mask ROM version
M38067EC-XXXFP			80P6N-A	One Time PROM version
M38067ECFP			80P6N-A	One Time PROM version (blank)
M38067MC-XXXGP			80P6S-A	Mask ROM version
M38067EC-XXXGP			80P6S-A	One Time PROM version
M38067ECGP			80P6S-A	One Time PROM version (blank)

GROUP EXPANSION

(EXTENDED OPERATING TEMPERATURE VERSION)

Mitsubishi plans to expand the 3806 group (extended operating temperature version) as follows:

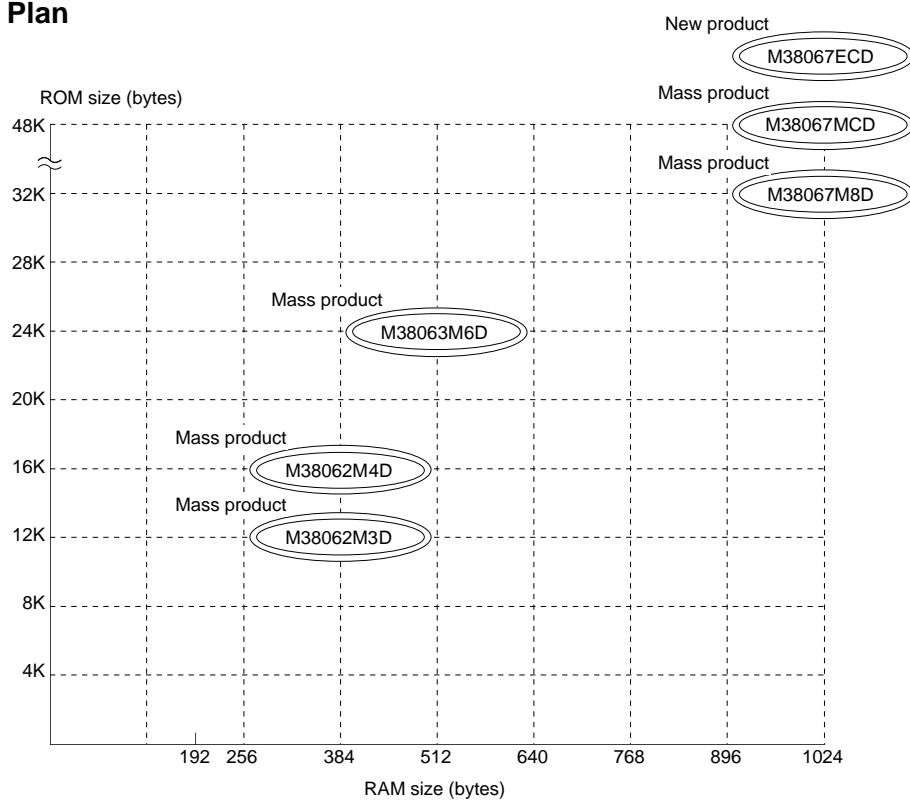
(1) Support for mask ROM version

- ROM/PROM capacity 12 K to 48 K bytes
- RAM capacity 384 to 1024 bytes

(2) Packages

80P6N-A 0.8 mm-pitch plastic molded QFP

Memory Expansion Plan



Currently supported products are listed below.

As of May 1996

Product name	(P) ROM size (bytes) ROM size for User in ()	RAM size (bytes)	Package	Remarks	
M38062M3DXXXFP	12288(12158)	384	80P6N-A	Mask ROM version	
M38062M4DXXXFP	16384(16254)	384		Mask ROM version	
M38063M6DXXXFP	24576(24446)	512		Mask ROM version	
M38067M8DXXXFP	32768(32638)	1024		Mask ROM version	
M38067MCDXXXFP	49152(49022)	1024		Mask ROM version	
M38067ECDXXXFP				One Time PROM version	
M38067ECDDFP				One Time PROM version (blank)	

GROUP EXPANSION (HIGH-SPEED VERSION)

Mitsubishi plans to expand the 3806 group (high-speed version) as follows:

(1) Support for mask ROM, One Time PROM, and EPROM versions

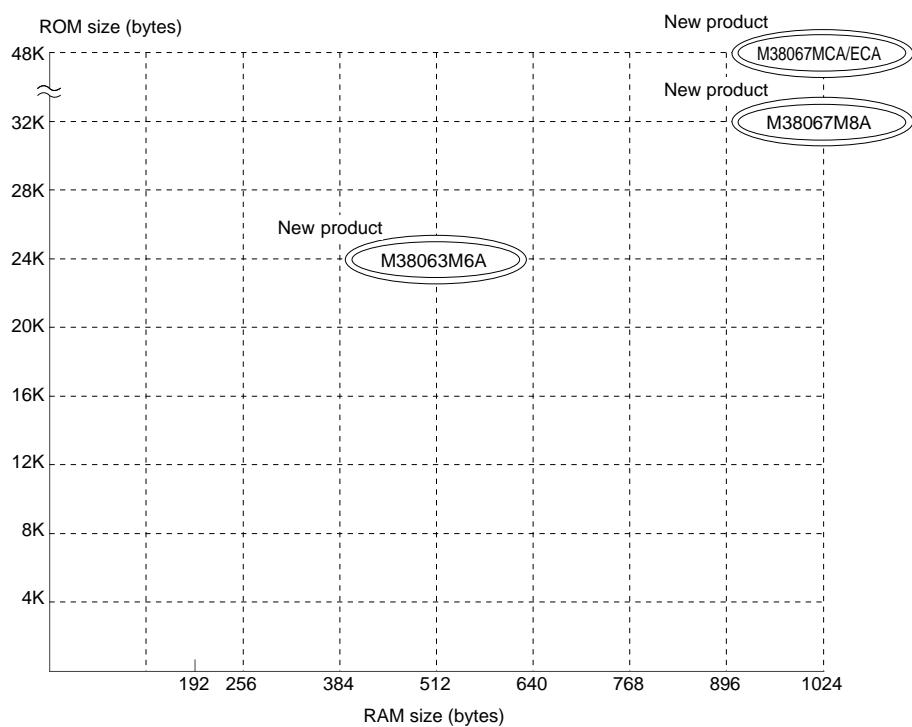
ROM/PROM capacity 24 K to 48 K bytes

RAM capacity 512 to 1024 bytes

(2) Packages

- 80P6N-A 0.8 mm-pitch plastic molded QFP
80P6S-A 0.65 mm-pitch plastic molded QFP
80P6D-A 0.5 mm-pitch plastic molded QFP
80D0 0.8 mm-pitch ceramic LCC (EPROM version)

Memory Expansion Plan



Products under development: the development schedule and specification may be revised without notice.

Currently supported products are listed below.

As of May 1996

Product name	(P) ROM size (bytes) ROM size for User in ()	RAM size (bytes)	Package	Remarks
M38063M6AXXXFP	24576 (24446)	512	80P6N-A	Mask ROM version
M38063M6AXXGP			80P6S-A	Mask ROM version
M38063M6AXXHP			80P6D-A	Mask ROM version
M38067M8AXXXFP	32768 (32638)	1024	80P6N-A	Mask ROM version
M38067M8AXXGP			80P6S-A	Mask ROM version
M38067MCAXXXFP	49152 (49022)	1024	80P6N-A	Mask ROM version
M38067ECAXXXFP			80P6N-A	One Time PROM version
M38067ECAPF			80P6N-A	One Time PROM version (blank)
M38067MCAXXXGP			80P6S-A	Mask ROM version
M38067ECAXXGP			80P6S-A	One Time PROM version
M38067ECAGP			80D0	One Time PROM version (blank)
M38067ECAF				EPROM version

FUNCTIONAL DESCRIPTION

Central Processing Unit (CPU)

The 3806 group uses the standard 740 family instruction set. Refer to the table of 740 family addressing modes and machine instructions or the SERIES 740 <Software> User's Manual for details on the instruction set.

Machine-resident 740 family instructions are as follows:

The FST and SLW instruction cannot be used.

The STP, WIT, MUL, and DIV instruction can be used.

CPU mode register

The CPU mode register is allocated at address 003B16.

The CPU mode register contains the stack page selection bit.

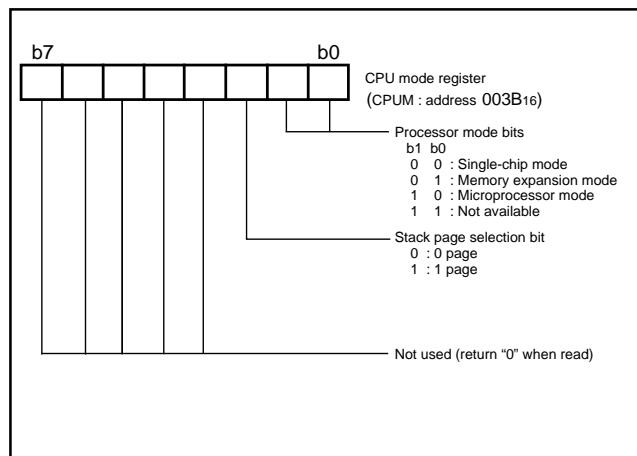


Fig. 1 Structure of CPU mode register

I/O Ports

Direction registers

The 3806 group has 72 programmable I/O pins arranged in nine I/O ports (ports P0 to P8). The I/O ports have direction registers which determine the input/output direction of each individual pin. Each bit in a direction register corresponds to one pin, each pin can be set to be input port or output port.

When “0” is written to the bit corresponding to a pin, that pin becomes an input pin. When “1” is written to that bit, that pin becomes an output pin.

If data is read from a pin which is set to output, the value of the port output latch is read, not the value of the pin itself. Pins set to input are floating. If a pin set to input is written to, only the port output latch is written to and the pin remains floating.

Pin	Name	Input/Output	I/O Format	Non-Port Function	Related SFRs	Ref.No.
P00 – P07	Port P0	Input/output, individual bits	CMOS 3-state output CMOS compatible input level	Address low-order byte output	CPU mode register	(1)
P10 – P17	Port P1	Input/output, individual bits	CMOS 3-state output CMOS compatible input level	Address high-order byte output	CPU mode register	
P20 – P27	Port P2	Input/output, individual bits	CMOS 3-state output CMOS compatible input level	Data bus I/O	CPU mode register	
P30 – P37	Port P3	Input/output, individual bits	CMOS 3-state output CMOS compatible input level	Control signal I/O	CPU mode register	
P40, P41	Port P4	Input/output, individual bits	CMOS 3-state output CMOS compatible input level			
P42/INT0, P43/INT1				External interrupt input	Interrupt edge selection register	(2)
P44/RxD, P45/TxD, P46/SCLK1, P47/SRDY1				Serial I/O1 function I/O	Serial I/O1 control register UART control register	(3) (4) (5)
						(6)
P50						(1)
P51/INT2, P52/INT3, P53/INT4	Port P5	Input/output, individual bits	CMOS 3-state output CMOS compatible input level	External interrupt input	Interrupt edge selection register	(2)
P54/CNTR0, P55/CNTR1				Timer X and Timer Y function I/O	Timer XY mode register	(7)
P56/DA1, P57/DA2				D-A conversion output	AD/DA control register	(8)
P60/A ₀ – P67/A ₇	Port P6	Input/output, individual bits	CMOS 3-state output CMOS compatible input level	A-D conversion input		(9)
P70/SIN ₂ , P71/SOUT ₂ , P72/SCLK ₂ , P73/SRDY ₂	Port P7	Input/output, individual bits	N-channel open-drain output CMOS compatible input level	Serial I/O2 function I/O	Serial I/O2 control register	(10) (11) (12)
P74 – P77						(13)
P80 – P87	Port P8	Input/output, individual bits	CMOS 3-state output CMOS compatible input level			(14)

Note 1: For details of the functions of ports P0 to P3 in modes other than single-chip mode, and how to use double-function ports as function I/O ports, refer to the applicable sections.

2: Make sure that the input level at each pin is either 0 V or Vcc during execution of the STP instruction.

When an input level is at an intermediate potential, a current will flow from Vcc to Vss through the input-stage gate.

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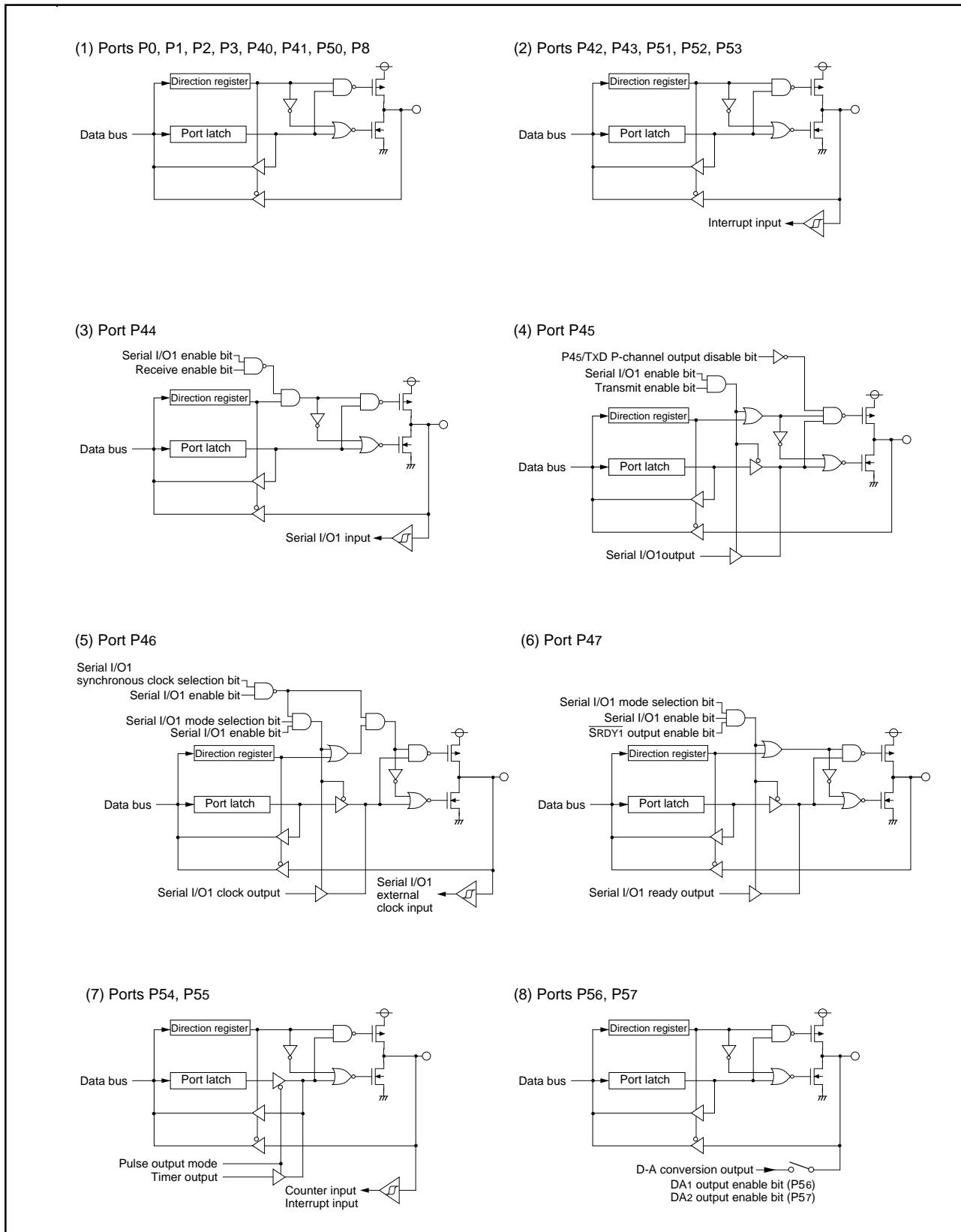


Fig. 4 Port block diagram (single-chip mode) (1)

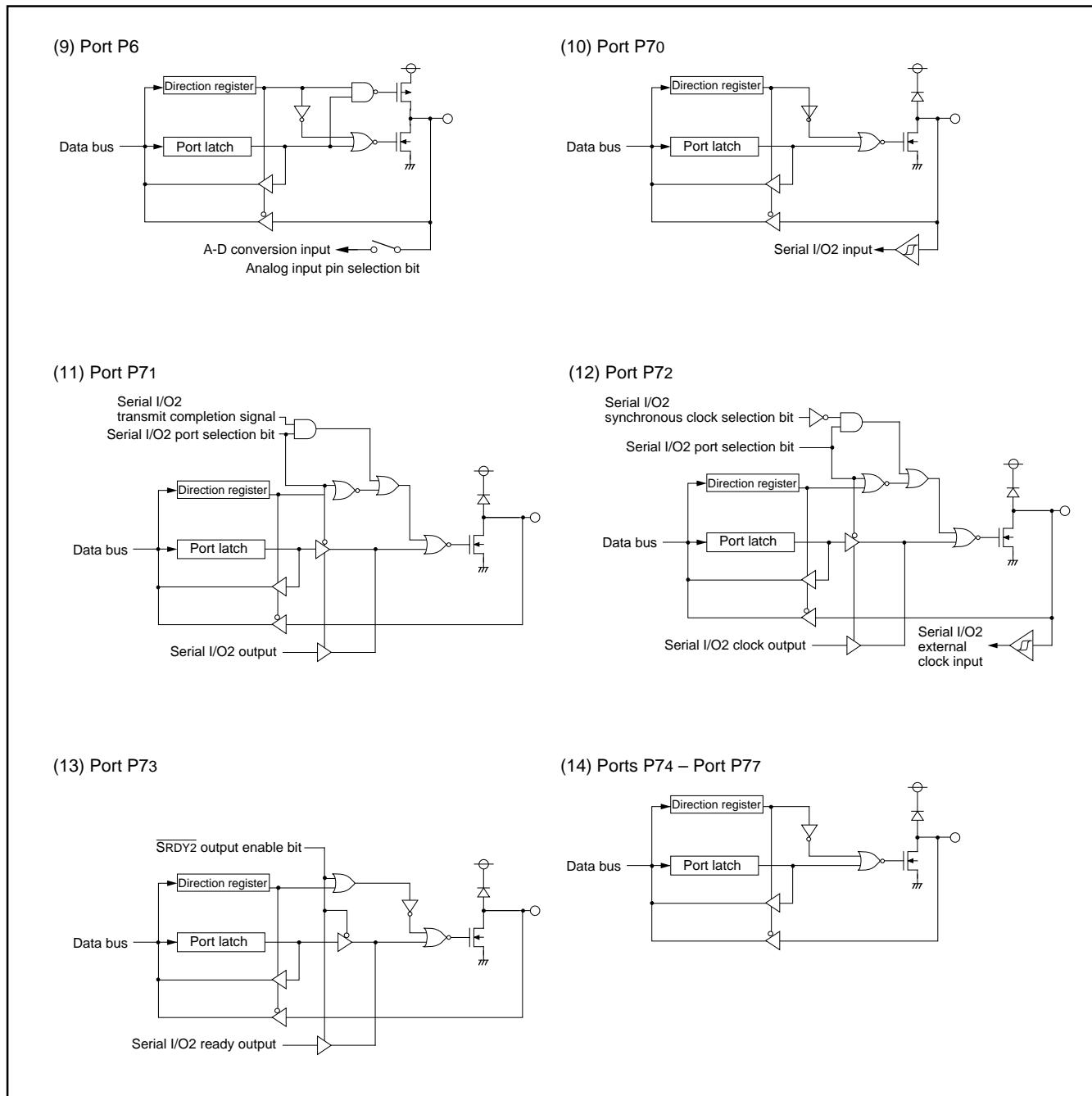


Fig. 5 Port block diagram (single-chip mode) (2)

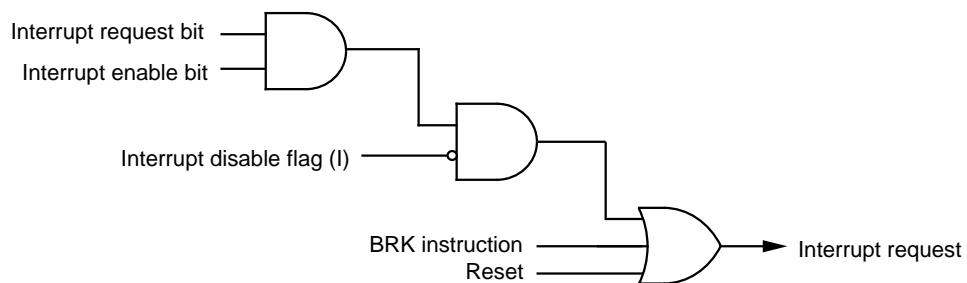


Fig. 6 Interrupt control

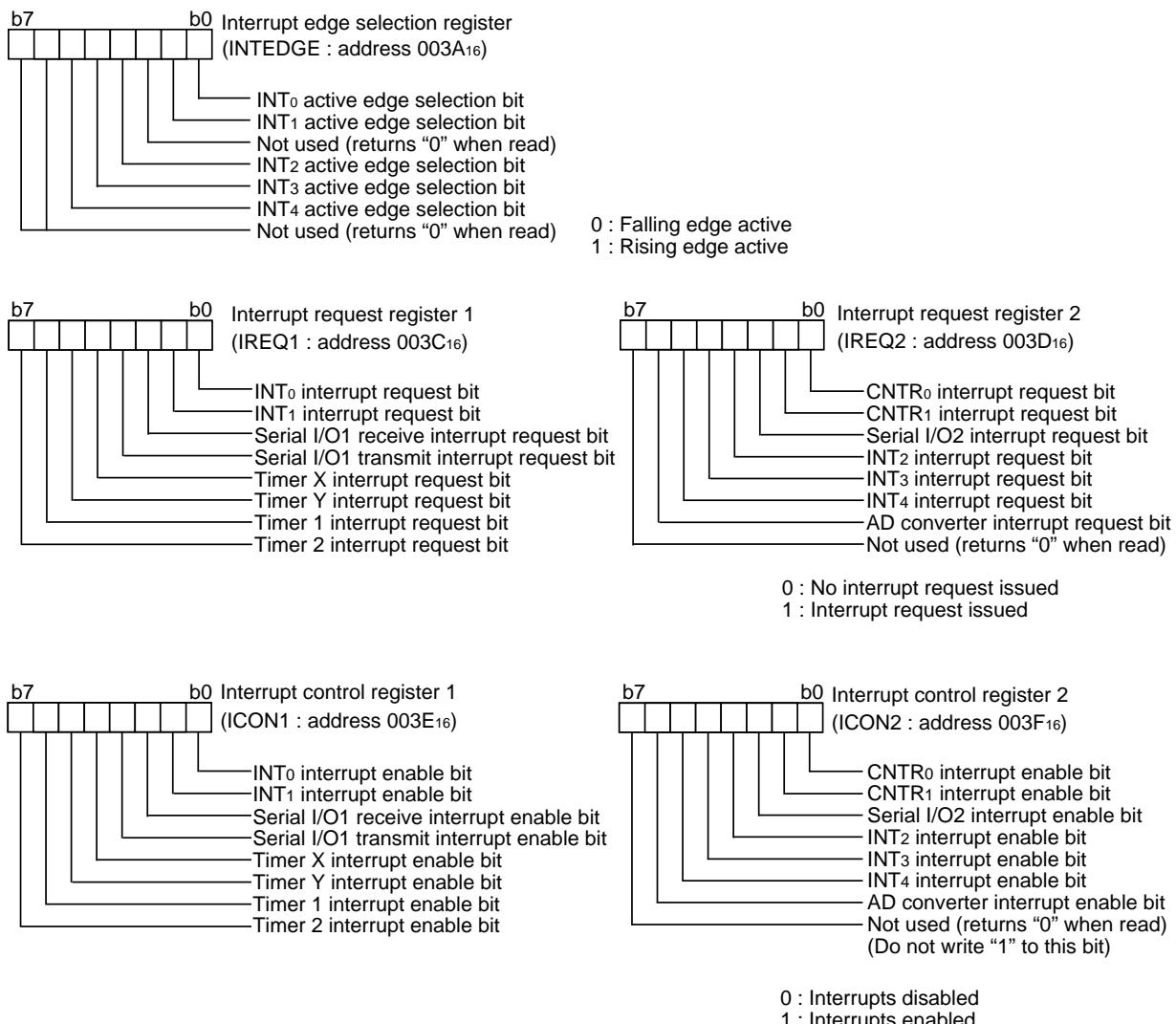


Fig. 7 Structure of interrupt-related registers

Timers

The 3806 group has four timers: timer X, timer Y, timer 1, and timer 2.

All timers are count down. When the timer reaches "0016", an underflow occurs at the next count pulse and the corresponding timer latch is reloaded into the timer and the count is continued. When a timer underflows, the interrupt request bit corresponding to that timer is set to "1".

The division ratio of each timer or prescaler is given by $1/(n + 1)$, where n is the value in the corresponding timer or prescaler latch.

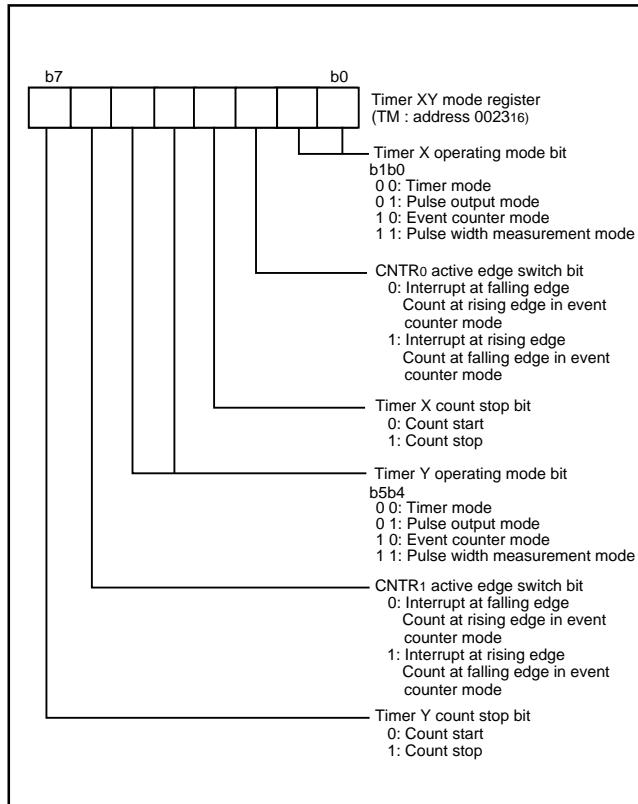


Fig. 8 Structure of timer XY register

Timer 1 and Timer 2

The count source of prescaler 12 is the oscillation frequency divided by 16. The output of prescaler 12 is counted by timer 1 and timer 2, and a timer underflow sets the interrupt request bit.

Timer X and Timer Y

Timer X and Timer Y can each be selected in one of four operating modes by setting the timer XY mode register.

Timer Mode

The timer counts $f(XIN)/16$ in timer mode.

Pulse Output Mode

Timer X (or timer Y) counts $f(XIN)/16$. Whenever the contents of the timer reach "0016", the signal output from the CNTR0 (or CNTR1) pin is inverted. If the CNTR0 (or CNTR1) active edge switch bit is "0", output begins at "H".

If it is "1", output starts at "L". When using a timer in this mode, set the corresponding port P54 (or port P55) direction register to output mode.

Event Counter Mode

Operation in event counter mode is the same as in timer mode, except the timer counts signals input through the CNTR0 or CNTR1 pin.

Pulse Width Measurement Mode

If the CNTR0 (or CNTR1) active edge selection bit is "0", the timer counts at the oscillation frequency divided by 16 while the CNTR0 (or CNTR1) pin is at "H". If the CNTR0 (or CNTR1) active edge switch bit is "1", the count continues during the time that the CNTR0 (or CNTR1) pin is at "L".

In all of these modes, the count can be stopped by setting the timer X (timer Y) count stop bit to "1". Every time a timer underflows, the corresponding interrupt request bit is set.

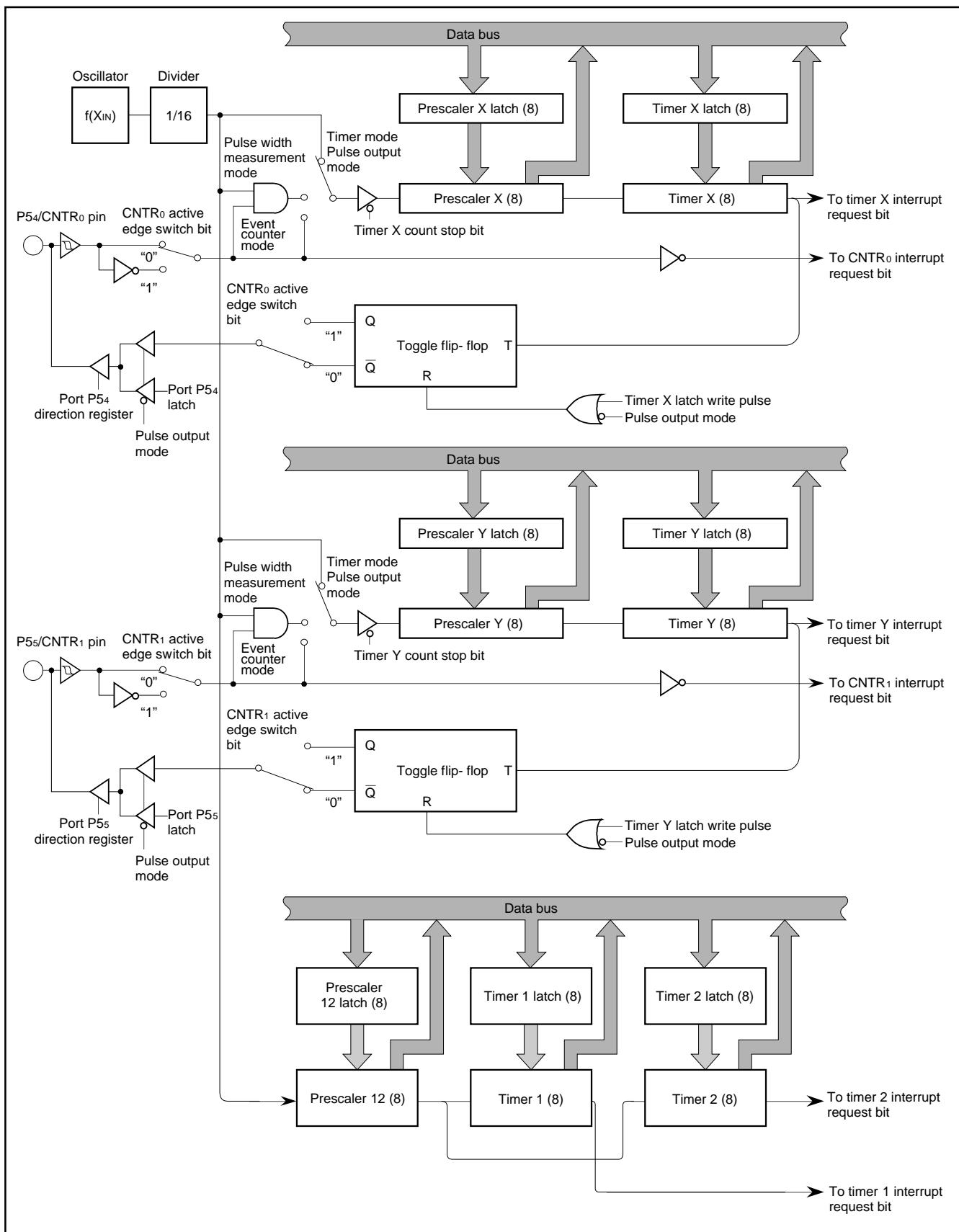


Fig. 9 Block diagram of timer X, timer Y, timer 1, and timer 2

Serial I/O1

Serial I/O1 can be used as either clock synchronous or asynchronous (UART) serial I/O. A dedicated timer is also provided for baud rate generation.

Clock synchronous serial I/O mode

Clock synchronous serial I/O1 mode can be selected by setting the mode selection bit of the serial I/O1 control register to "1".

For clock synchronous serial I/O1, the transmitter and the receiver must use the same clock. If an internal clock is used, transfer is started by a write signal to the TB/RB (address 001816).

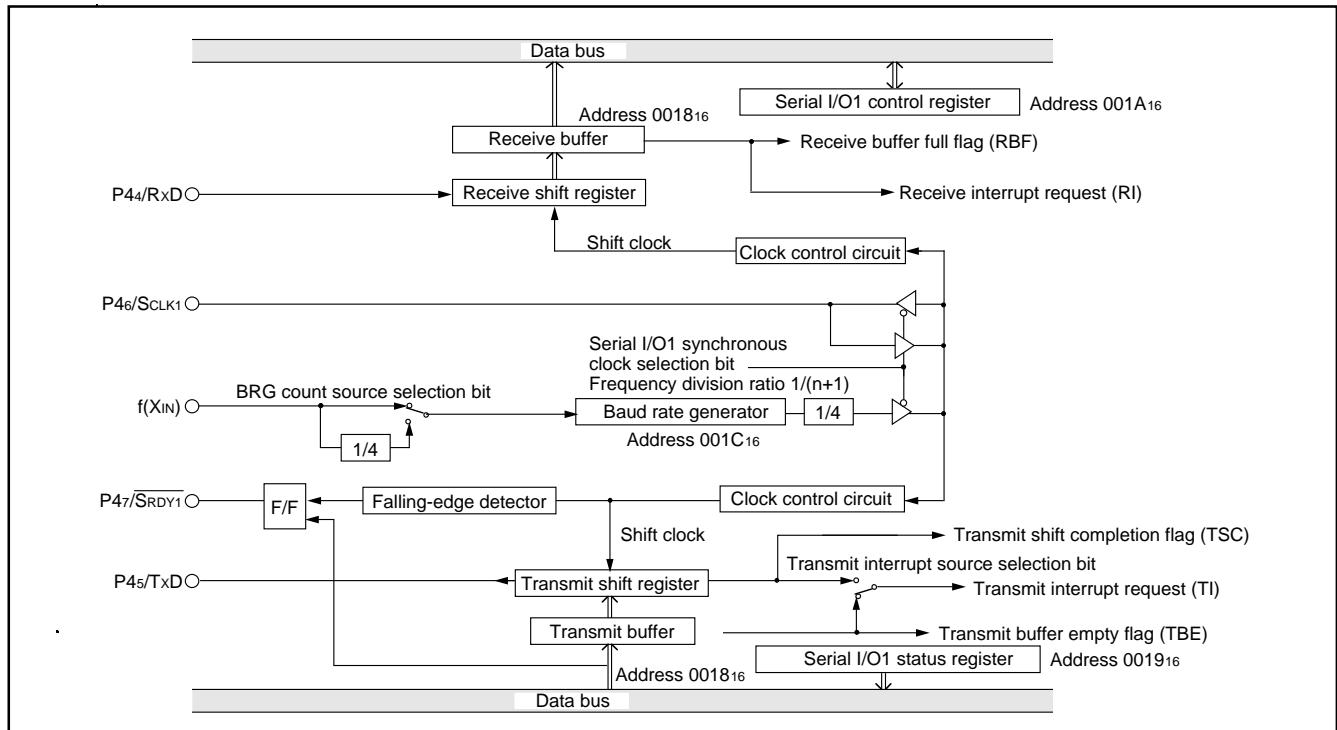


Fig. 10 Block diagram of clock synchronous serial I/O1

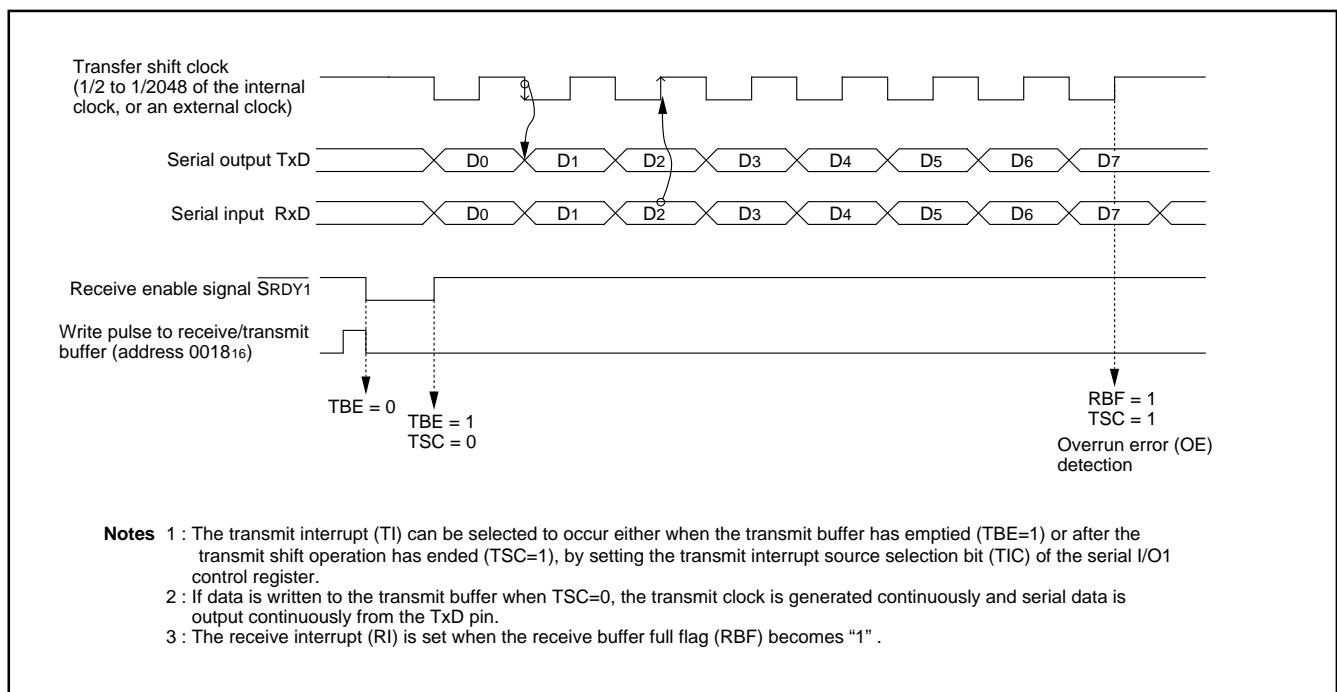


Fig. 11 Operation of clock synchronous serial I/O1 function

Asynchronous serial I/O (UART) mode

Clock asynchronous serial I/O mode (UART) can be selected by clearing the serial I/O mode selection bit of the serial I/O control register to "0".

Eight serial data transfer formats can be selected, and the transfer formats used by a transmitter and receiver must be identical.

The transmit and receive shift registers each have a buffer, but the

two buffers have the same address in memory. Since the shift register cannot be written to or read from directly, transmit data is written to the transmit buffer, and receive data is read from the receive buffer.

The transmit buffer can also hold the next data to be transmitted, and the receive buffer can hold a character while the next character is being received.

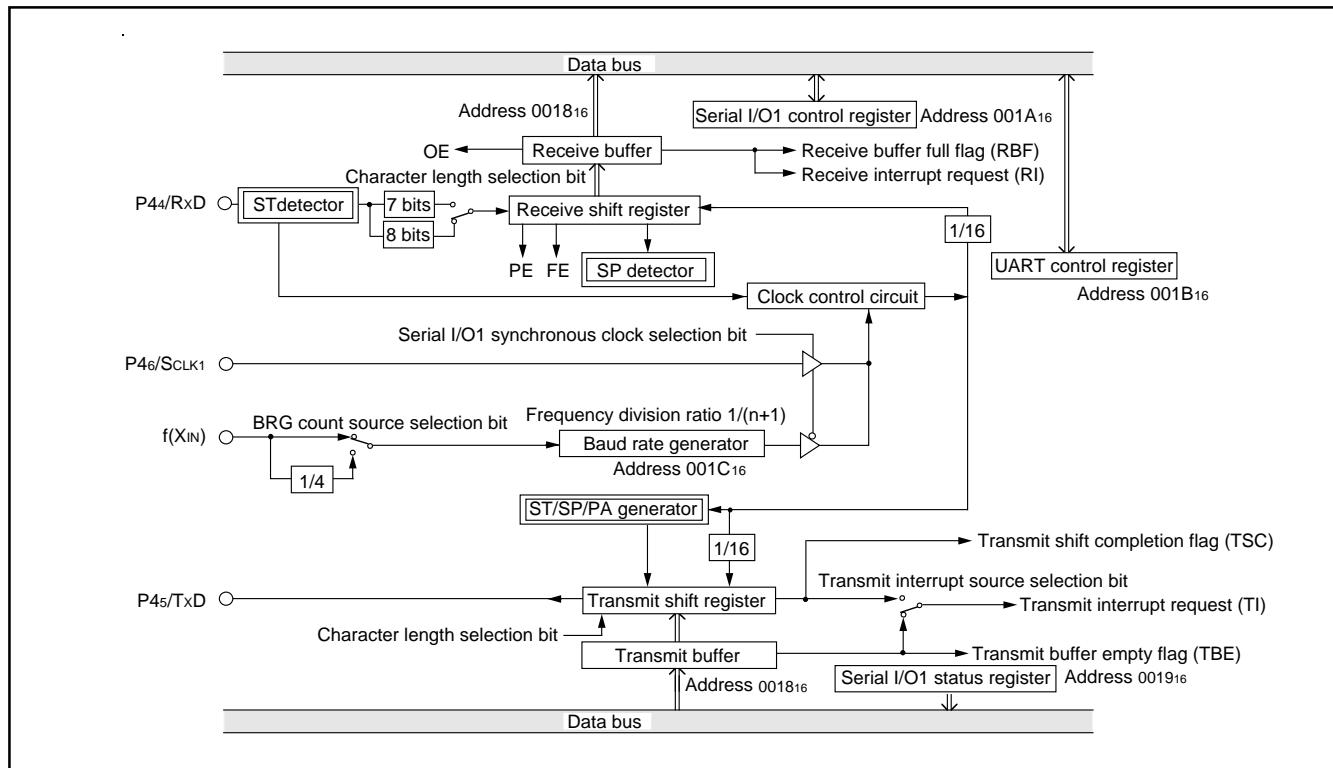


Fig. 12 Block diagram of UART serial I/O

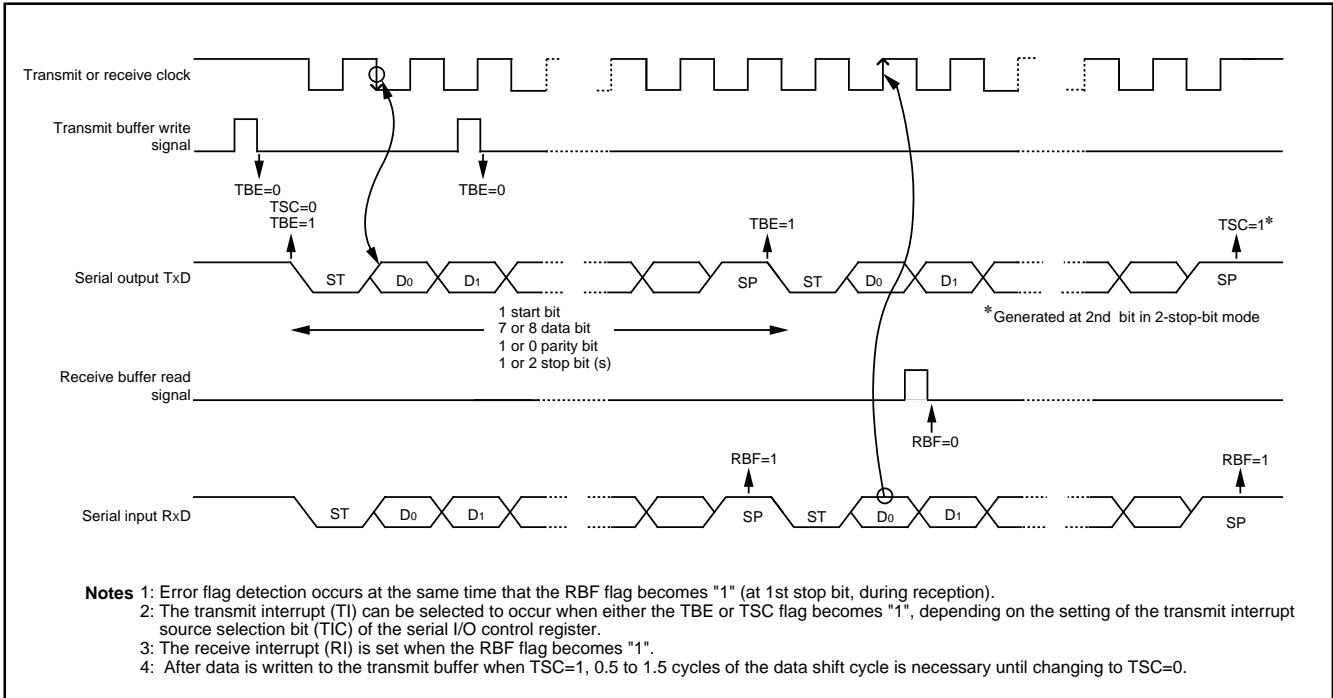


Fig. 13 Operation of UART serial I/O function

Serial I/O1 control register (SIO1CON) 001A16

The serial I/O control register consists of eight control bits for the serial I/O function.

UART control register (UARTCON) 001B16

The UART control register consists of four control bits (bits 0 to 3) which are valid when asynchronous serial I/O is selected and set the data format of an data transfer. One bit in this register (bit 4) is always valid and sets the output structure of the P45/TxD pin.

Serial I/O1 status register (SIO1STS) 001916

The read-only serial I/O1 status register consists of seven flags (bits 0 to 6) which indicate the operating status of the serial I/O function and various errors.

Three of the flags (bits 4 to 6) are valid only in UART mode.

The receive buffer full flag (bit 1) is cleared to "0" when the receive buffer is read.

If there is an error, it is detected at the same time that data is transferred from the receive shift register to the receive buffer, and the receive buffer full flag is set. A write to the serial I/O status register clears all the error flags OE, PE, FE, and SE (bit 3 to bit 6, re-

spectively). Writing "0" to the serial I/O enable bit SIOE (bit 7 of the Serial I/O Control Register) also clears all the status flags, including the error flags.

All bits of the serial I/O1 status register are initialized to "0" at reset, but if the transmit enable bit (bit 4) of the serial I/O control register has been set to "1", the transmit shift completion flag (bit 2) and the transmit buffer empty flag (bit 0) become "1".

Transmit buffer/Receive buffer register (TB/RB) 001816

The transmit buffer and the receive buffer are located at the same address. The transmit buffer is write-only and the receive buffer is read-only. If a character bit length is 7 bits, the MSB of data stored in the receive buffer is "0".

Baud rate generator (BRG) 001C16

The baud rate generator determines the baud rate for serial transfer.

The baud rate generator divides the frequency of the count source by $1/(n + 1)$, where n is the value written to the baud rate generator.

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

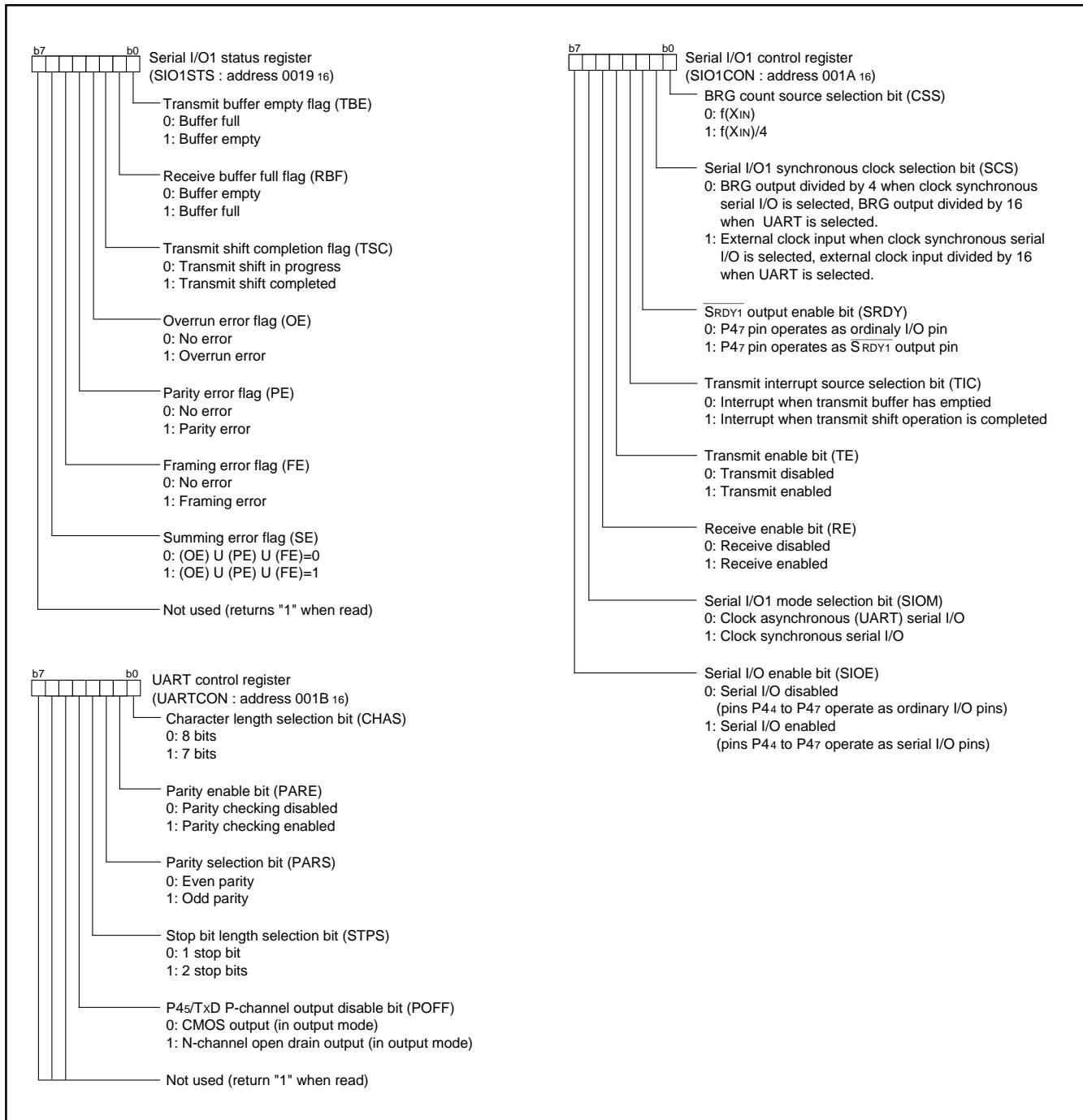


Fig. 14 Structure of serial I/O control registers

Serial I/O2

The serial I/O2 function can be used only for clock synchronous serial I/O.

For clock synchronous serial I/O the transmitter and the receiver must use the same clock. If the internal clock is used, transfer is started by a write signal to the serial I/O2 register.

Serial I/O2 control register (SIO2CON) 001D16

The serial I/O2 control register contains seven bits which control various serial I/O functions.

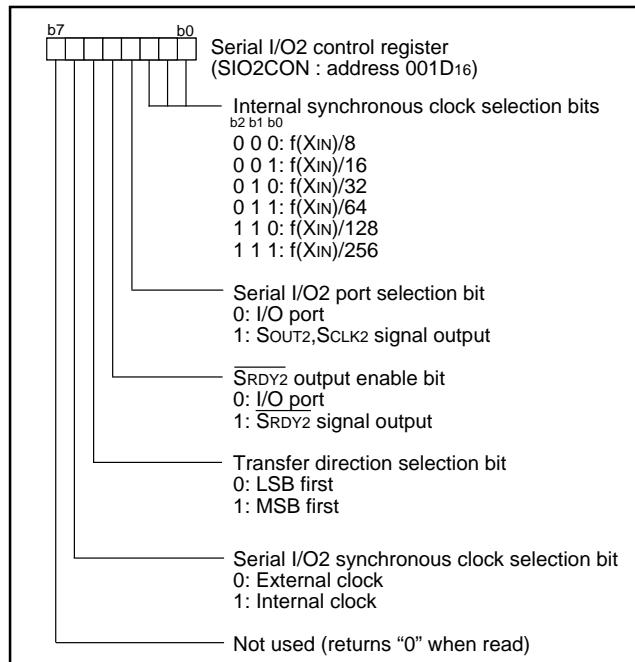


Fig. 15 Structure of serial I/O2 control register

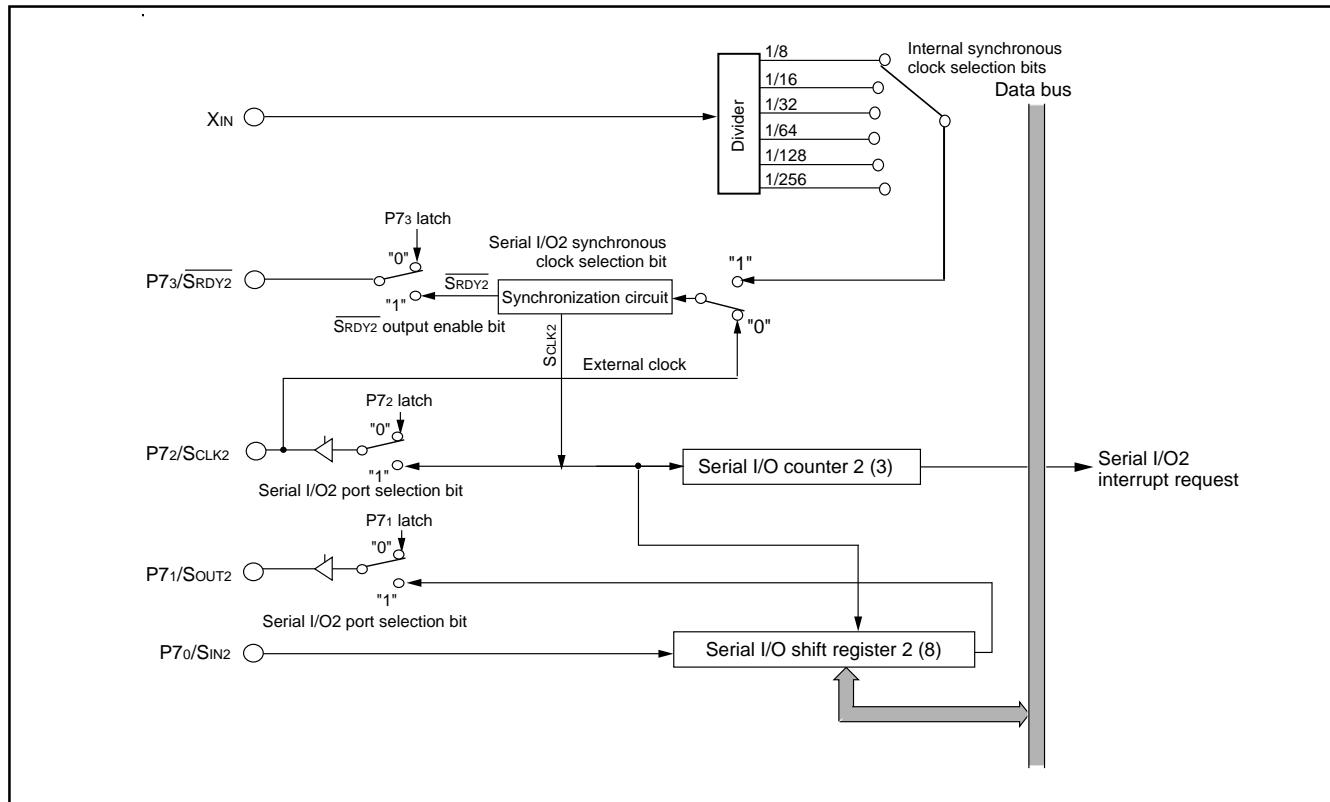


Fig. 16 Block diagram of serial I/O2 function

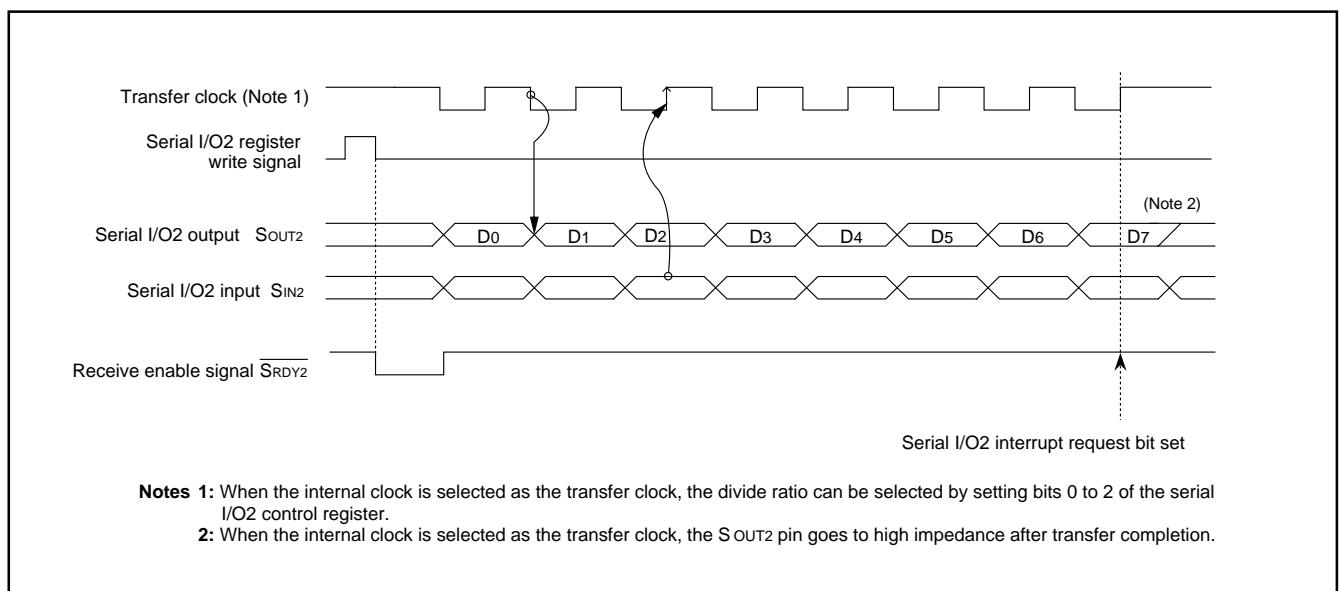


Fig. 17 Timing of serial I/O2 function

A-D Converter

The functional blocks of the A-D converter are described below.

[A-D conversion register]

The A-D conversion register is a read-only register that stores the result of an A-D conversion. When reading this register during an A-D conversion, the previous conversion result is read.

[AD/DA control register]

The AD/DA control register controls the A-D conversion process. Bits 0 to 2 select a specific analog input pin. Bit 3 signals the completion of an A-D conversion. The value of this bit remains at "0" during an A-D conversion, and changes to "1" when an A-D conversion ends. Writing "0" to this bit starts the A-D conversion. Bits 6 and 7 are used to control the output of the D-A converter.

[Comparison voltage generator]

The comparison voltage generator divides the voltage between AVss and VREF into 256, and outputs the divided voltages.

[Channel selector]

The channel selector selects one of the ports P60/AN0 to P67/AN7, and inputs the voltage to the comparator.

[Comparator and Control circuit]

The comparator and control circuit compares an analog input voltage with the comparison voltage, then stores the result in the A-D conversion register. When an A-D conversion is complete, the control circuit sets the AD conversion completion bit and the AD interrupt request bit to "1".

Note that the comparator is constructed linked to a capacitor, so set f(XIN) to 500 kHz or more during an A-D conversion.

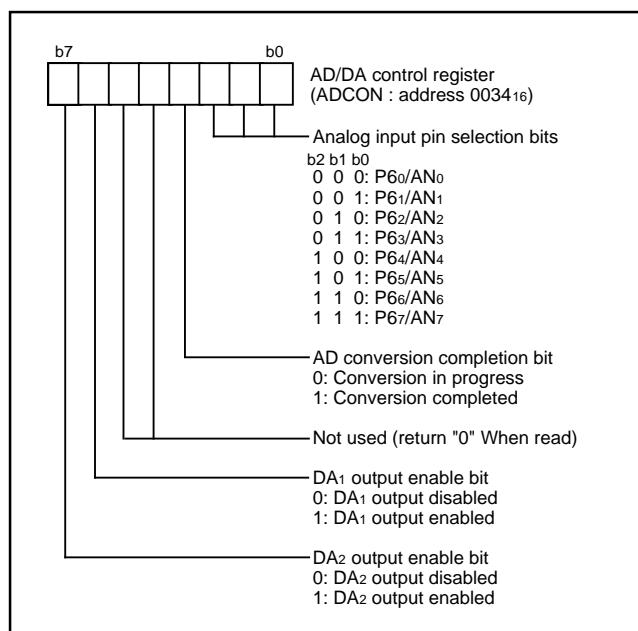


Fig.18 Structure of AD/DA control register

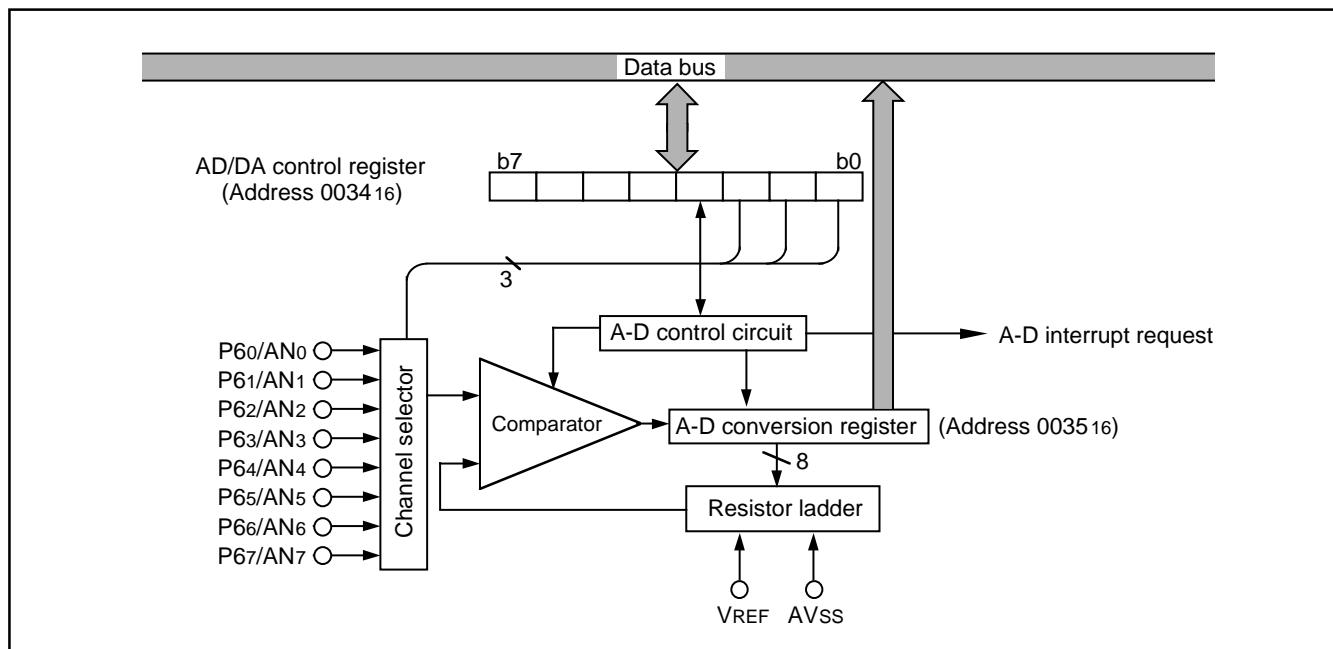


Fig. 19 Block diagram of A-D converter

D-A Converter

The 3806 group has two internal D-A converters (DA1 and DA2) with 8-bit resolutions.

The D-A converter is performed by setting the value in the D-A conversion register. The result of D-A converter is output from the DA1 or DA2 pin by setting the DA output enable bit to "1".

When using the D-A converter, the corresponding port direction register bit (DA1/P56 or DA2/P57) should be set to "0" (input status).

The output analog voltage V is determined by the value n (base 10) in the D-A conversion register as follows:

$$V = V_{REF} \times n/256 \quad (n = 0 \text{ to } 255)$$

Where V_{REF} is the reference voltage.

At reset, the D-A conversion registers are cleared to "0016", the DA output enable bits are cleared to "0", and the P56/DA1 and P57/DA2 pins are set to input (high impedance).

The D-A output is not buffered, so connect an external buffer when driving a low-impedance load.

Set V_{CC} to 4.0 V or more when using the D-A converter.

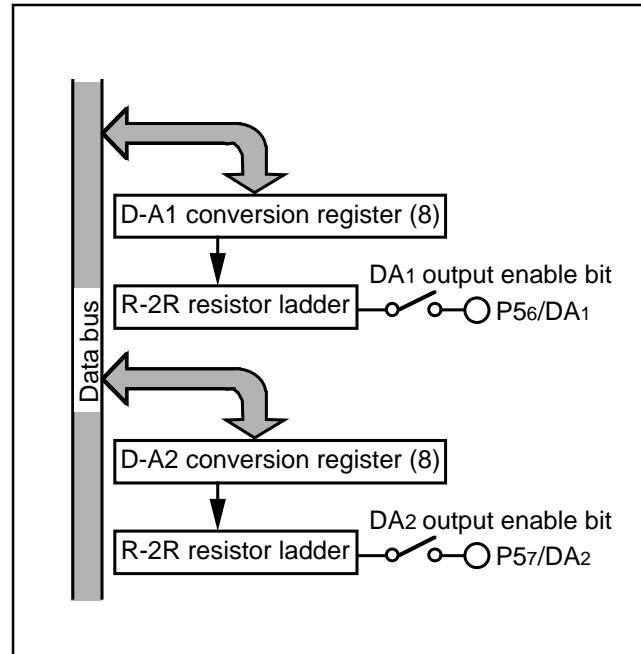


Fig. 20 Block diagram of D-A converter

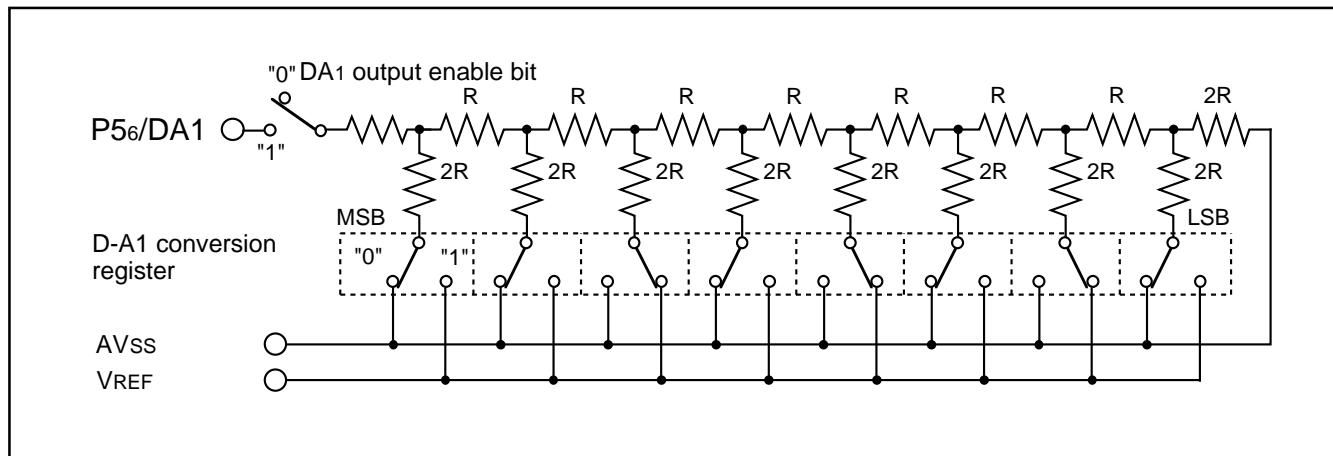


Fig. 21 Equivalent connection circuit of D-A converter

Reset Circuit

To reset the microcomputer, the RESET pin should be held at an "L" level for 2 µs or more. Then the RESET pin is returned to an "H" level (Note 1), reset is released. Internal operation does not begin until after 8 to 13 XIN clock cycles are completed. After the reset is completed, the program starts from the address contained in address FFFD₁₆ (high-order byte) and address FFFC₁₆ (low-order byte).

Make sure that the reset input voltage is less than 0.8 V for VCC of 4.0 V (Note 2).

Note 1. The power source voltage should be between the following voltage.

- Between 3.0 V and 5.5 V for standard version
- Between 4.0 V and 5.5 V for extended operating temperature version
- Between 2.7 V and 5.5 V for high-speed version

Note 2. Reset input voltage is less than the following voltage.

- 0.6 V for VCC = 3.0 V
- 0.8 V for VCC = 4.0 V
- 0.54 V for VCC = 2.7 V

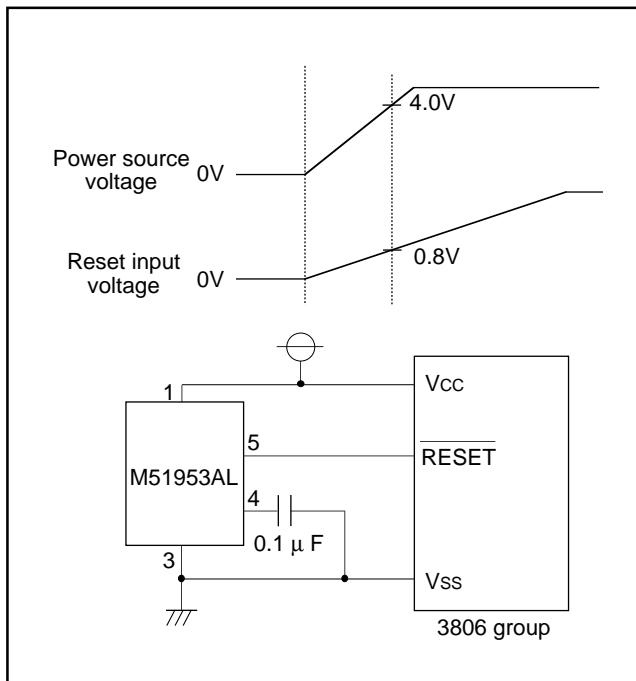


Fig. 22 Example of reset circuit

	Address	Register contents
(1) Port P0 direction register	(0001 ₁₆) •••	0016
(2) Port P1 direction register	(0003 ₁₆) •••	0016
(3) Port P2 direction register	(0005 ₁₆) •••	0016
(4) Port P3 direction register	(0007 ₁₆) •••	0016
(5) Port P4 direction register	(0009 ₁₆) •••	0016
(6) Port P5 direction register	(000B ₁₆) •••	0016
(7) Port P6 direction register	(000D ₁₆) •••	0016
(8) Port P7 direction register	(000F ₁₆) •••	0016
(9) Port P8 direction register	(0011 ₁₆) •••	0016
(10) Serial I/O1 status register	(0019 ₁₆) •••	1 0 0 0 0 0 0 0 0 0
(11) Serial I/O1 control register	(001A ₁₆) •••	0016
(12) UART control register	(001B ₁₆) •••	1 1 1 0 0 0 0 0 0 0
(13) Serial I/O2 control register	(001D ₁₆) •••	0016
(14) Prescaler 12	(0020 ₁₆) •••	FF ₁₆
(15) Timer 1	(0021 ₁₆) •••	0116
(16) Timer 2	(0022 ₁₆) •••	FF ₁₆
(17) Timer XY mode register	(0023 ₁₆) •••	0016
(18) Prescaler X	(0024 ₁₆) •••	FF ₁₆
(19) Timer X	(0025 ₁₆) •••	FF ₁₆
(20) Prescaler Y	(0026 ₁₆) •••	FF ₁₆
(21) Timer Y	(0027 ₁₆) •••	FF ₁₆
(22) AD/DA control register	(0034 ₁₆) •••	0 0 0 0 1 0 0 0
(23) D-A1 conversion register	(0036 ₁₆) •••	0016
(24) D-A2 conversion register	(0037 ₁₆) •••	0016
(25) Interrupt edge selection register	(003A ₁₆) •••	0016
(26) CPU mode register	(003B ₁₆) •••	0 0 0 0 0 0 0 * 0
(27) Interrupt request register 1	(003C ₁₆) •••	0016
(28) Interrupt request register 2	(003D ₁₆) •••	0016
(29) Interrupt control register 1	(003E ₁₆) •••	0016
(30) Interrupt control register 2	(003F ₁₆) •••	0016
(31) Processor status register	(PS)	x x x x x 1 x x
(32) Program counter	(PC _H)	Contents of address FFFD ₁₆
	(PC _L)	Contents of address FFFC ₁₆

Note. x : Undefined

* : The initial values of CM₁ are determined by the level at the CNVss pin.

The contents of all other registers and RAM are undefined after a reset, so they must be initialized by software.

Fig. 23 Internal status of microcomputer after reset

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

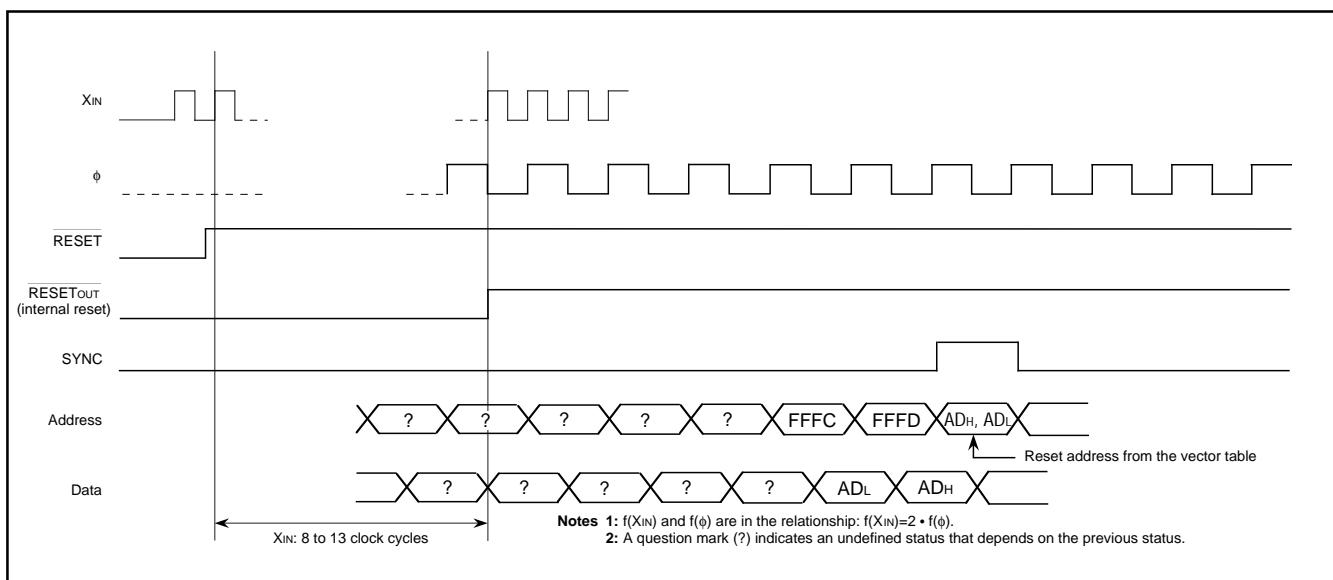


Fig. 24 Timing of reset

Clock Generating Circuit

An oscillation circuit can be formed by connecting a resonator between XIN and XOUT. To supply a clock signal externally, input it to the XIN pin and make the XOUT pin open.

Oscillation control

Stop Mode

If the STP instruction is executed, the internal clock ϕ stops at an "H". Timer 1 is set to "0116" and prescaler 12 is set to "FF16".

Oscillator restarts when an external interrupt is received, but the internal clock ϕ remains at an "H" until timer 1 underflow.

This allows time for the clock circuit oscillation to stabilize.

If oscillator is restarted by a reset, no wait time is generated, so keep the RESET pin at an "L" level until oscillation has stabilized.

Wait Mode

If the WIT instruction is executed, the internal clock ϕ stops at an "H" level, but the oscillator itself does not stop. The internal clock restarts if a reset occurs or when an interrupt is received.

Since the oscillator does not stop, normal operation can be started immediately after the clock is restarted.

To ensure that interrupts will be received to release the STP or WIT state, interrupt enable bits must be set to "1" before the STP or WIT instruction is executed.

When the STP status is released, prescaler 12 and timer 1 will start counting and reset will not be released until timer 1 underflows, so set the timer 1 interrupt enable bit to "0" before the STP instruction is executed.

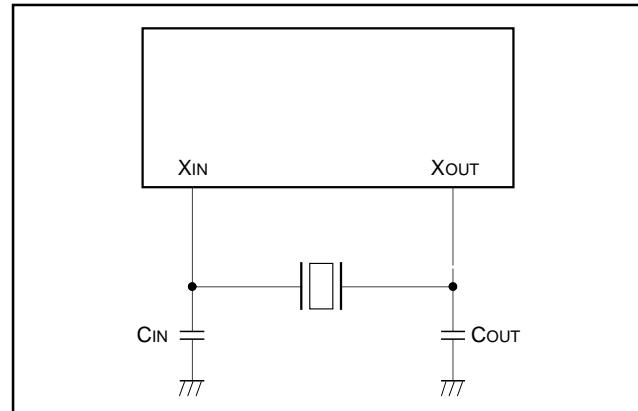


Fig. 25 Ceramic resonator circuit

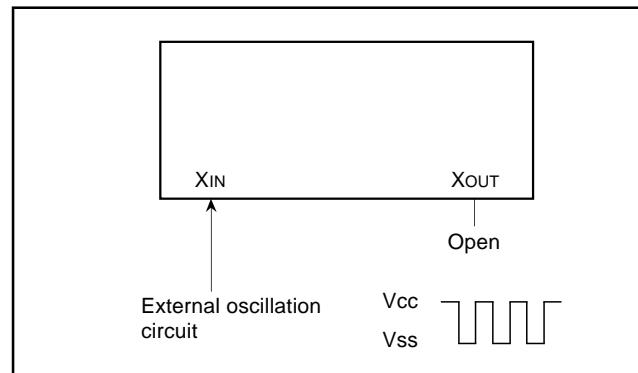


Fig. 26 External clock input circuit

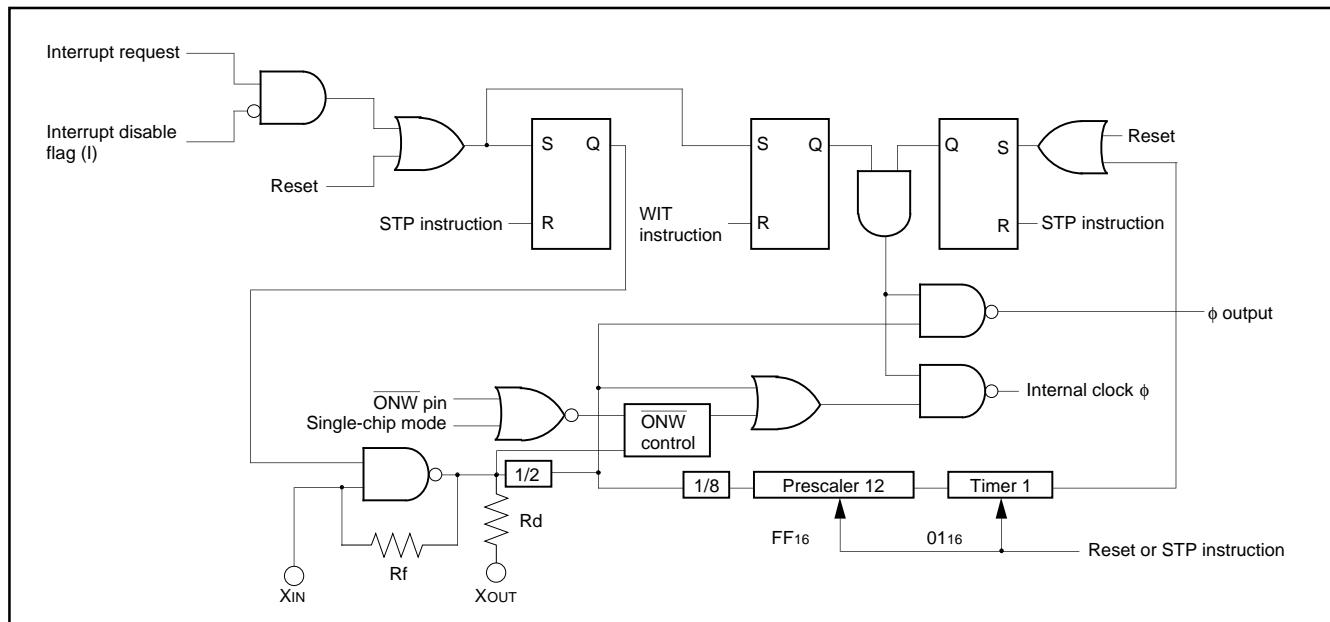


Fig. 27 Block diagram of clock generating circuit

Processor Modes

Single-chip mode, memory expansion mode, and microprocessor mode can be selected by changing the contents of the processor mode bits CM0 and CM1 (bits 0 and 1 of address 003B₁₆). In memory expansion mode and microprocessor mode, memory can be expanded externally through ports P0 to P3. In these modes, ports P0 to P3 lose their I/O port functions and become bus pins.

Table 2. Functions of ports in memory expansion mode and microprocessor mode

Port Name	Function
Port P0	Outputs low-order byte of address.
Port P1	Outputs high-order byte of address.
Port P2	Operates as I/O pins for data D7 to D0 (including instruction codes).
Port P3	P30 and P31 function only as output pins (except that the port latch cannot be read). P32 is the <u>ONW</u> input pin. P33 is the RESETOUT output pin. (Note) P34 is the ϕ output pin. P35 is the SYNC output pin. P36 is the WR output pin, and P37 is the RD output pin.

Note: If CNVss is connected to Vss, the microcomputer goes to single-chip mode after a reset, so this pin cannot be used as the RESETOUT output pin.

Single-Chip Mode

Select this mode by resetting the microcomputer with CNVss connected to Vss.

Memory Expansion Mode

Select this mode by setting the processor mode bits to "01" in software with CNVss connected to Vss. This mode enables external memory expansion while maintaining the validity of the internal ROM. Internal ROM will take precedence over external memory if addresses conflict.

Microprocessor Mode

Select this mode by resetting the microcomputer with CNVss connected to Vcc, or by setting the processor mode bits to "10" in software with CNVss connected to Vss. In microprocessor mode, the internal ROM is no longer valid and external memory must be used.

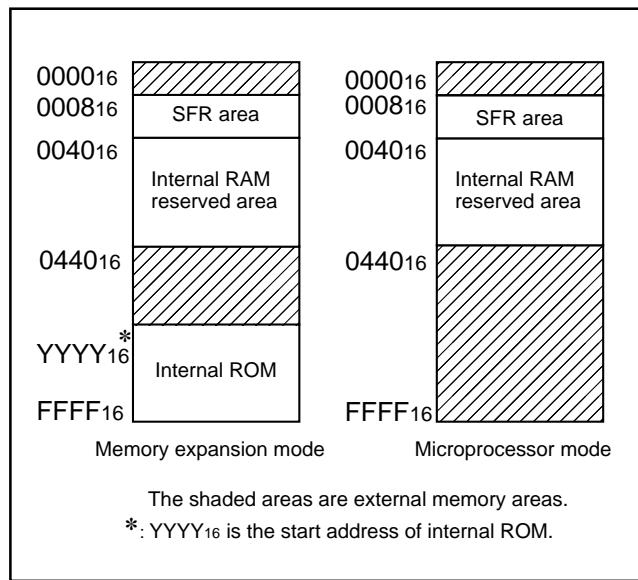


Fig. 28 Memory maps in various processor modes

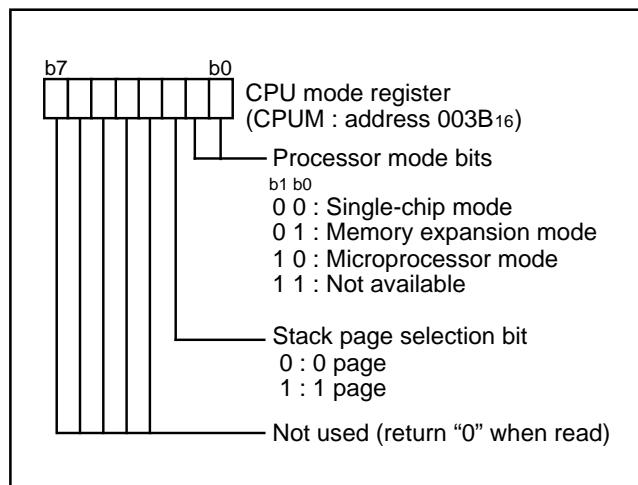
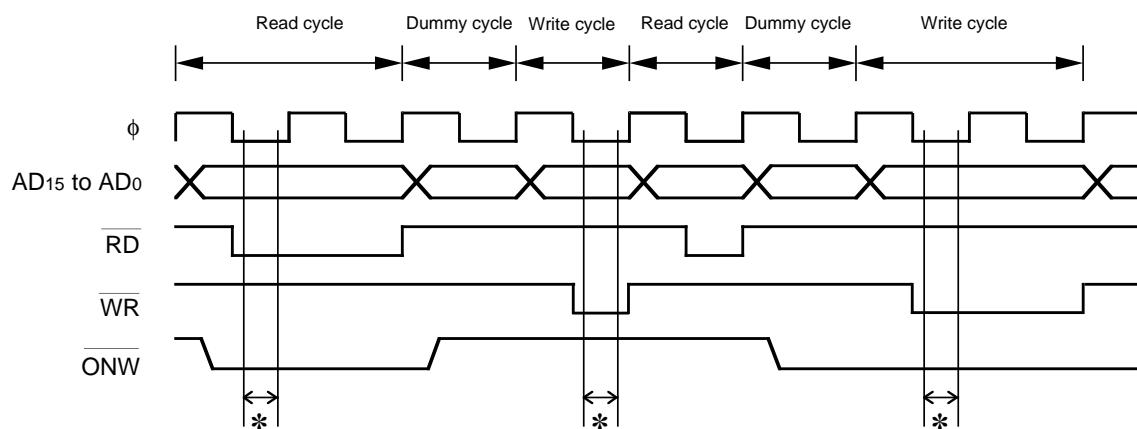


Fig. 29 Structure of CPU mode register

Bus control with memory expansion

The 3806 group has a built-in ONW function to facilitate access to external memory and I/O devices in memory expansion mode or microprocessor mode.

If an "L" level signal is input to the ONW pin when the CPU is in a read or write state, the corresponding read or write cycle is extended by one cycle of ϕ . During this extended period, the RD or WR signal remains at "L". This extension period is valid only for writing to and reading from addresses 0000₁₆ to 0007₁₆ and 0440₁₆ to FFFF₁₆ in microprocessor mode, 0440₁₆ to YYYY₁₆ in memory expansion mode, and only read and write cycles are extended.



* : Period during which ONW input signal is received
 During this period, the ONW signal must be fixed at either "H" or "L". At all other times, the input level of the ONW signal has no affect on operations.
 The bus cycles is not extended for an address in the area 0008₁₆ to 043F₁₆, regardless of whether the ONW signal is received.

Fig. 30 ONW function timing

NOTES ON PROGRAMMING

Processor Status Register

The contents of the processor status register (PS) after a reset are undefined, except for the interrupt disable flag (I) which is "1". After a reset, initialize flags which affect program execution.

In particular, it is essential to initialize the index X mode (T) and the decimal mode (D) flags because of their effect on calculations.

Interrupts

The contents of the interrupt request bits do not change immediately after they have been written. After writing to an interrupt request register, execute at least one instruction before executing a BBC or BBS instruction.

Decimal Calculations

To calculate in decimal notation, set the decimal mode flag (D) to "1", then execute an ADC or SBC instruction. Only the ADC and SBC instructions yield proper decimal results. After executing an ADC or SBC instruction, execute at least one instruction before executing a SEC, CLC, or CLD instruction.

In decimal mode, the values of the negative (N), overflow (V), and zero (Z) flags are invalid.

The carry flag can be used to indicate whether a carry or borrow has occurred. Initialize the carry flag before each calculation.

Clear the carry flag before an ADC and set the flag before an SBC.

Timers

If a value n (between 0 and 255) is written to a timer latch, the frequency division ratio is $1/(n + 1)$.

Multiplication and Division Instructions

The index X mode (T) and the decimal mode (D) flags do not affect the MUL and DIV instruction.

The execution of these instructions does not change the contents of the processor status register.

Ports

The contents of the port direction registers cannot be read.

The following cannot be used:

- The data transfer instruction (LDA, etc.)
- The operation instruction when the index X mode flag (T) is "1"
- The addressing mode which uses the value of a direction register as an index
- The bit-test instruction (BBC or BBS, etc.) to a direction register
- The read-modify-write instruction (ROR, CLB, or SEB, etc.) to a direction register

Use instructions such as LDM and STA, etc., to set the port direction registers.

Serial I/O

In clock synchronous serial I/O, if the receive side is using an external clock and it is to output the SRDY1 signal, set the transmit enable bit, the receive enable bit, and the SRDY1 output enable bit to "1".

Serial I/O1 continues to output the final bit from the TXD pin after transmission is completed. The SOUT2 pin from serial I/O2 goes to high impedance after transmission is completed.

A-D Converter

The comparator uses internal capacitors whose charge will be lost if the clock frequency is too low.

Make sure that f(XIN) is at least 500 kHz during an A-D conversion. (If the ONW pin has been set to "L", the A-D conversion will take twice as long to match the longer bus cycle, and so f(XIN) must be at least 1 MHz.)

Do not execute the STP or WIT instruction during an A-D conversion.

D-A Converter

The accuracy of the D-A converter becomes poor rapidly under the VCC = 4.0 V or less condition.

Instruction Execution Time

The instruction execution time is obtained by multiplying the frequency of the internal clock ϕ by the number of cycles needed to execute an instruction.

The number of cycles required to execute an instruction is shown in the list of machine instructions.

The frequency of the internal clock ϕ is half of the XIN frequency. When the ONW function is used in modes other than single-chip mode, the frequency of the internal clock ϕ may be one fourth the XIN frequency.

Memory Expansion Mode and Microprocessor Mode

Execute the LDM or STA instruction for writing to port P3 (address 000616) in memory expansion mode and microprocessor mode.

Set areas which can be read out and write to port P3 (address 000616) in a memory, using the read-modify-write instruction (SEB, CLB).

DATA REQUIRED FOR MASK ORDERS

The following are necessary when ordering a mask ROM production:

1. Mask ROM Order Confirmation Form
2. Mark Specification Form
3. Data to be written to ROM, in EPROM form (three identical copies)

ROM PROGRAMMING METHOD

The built-in PROM of the blank One Time PROM version and built-in EEPROM version can be read or programmed with a general-purpose PROM programmer using a special programming adapter. Set the address of PROM programmer in the user ROM area.

Package	Name of Programming Adapter
80P6N-A	PCA4738F-80A
80P6S-A	PCA4738G-80A
80D0	PCA4738L-80A

The PROM of the blank One Time PROM version is not tested or screened in the assembly process and following processes. To ensure proper operation after programming, the procedure shown in Figure 40 is recommended to verify programming.

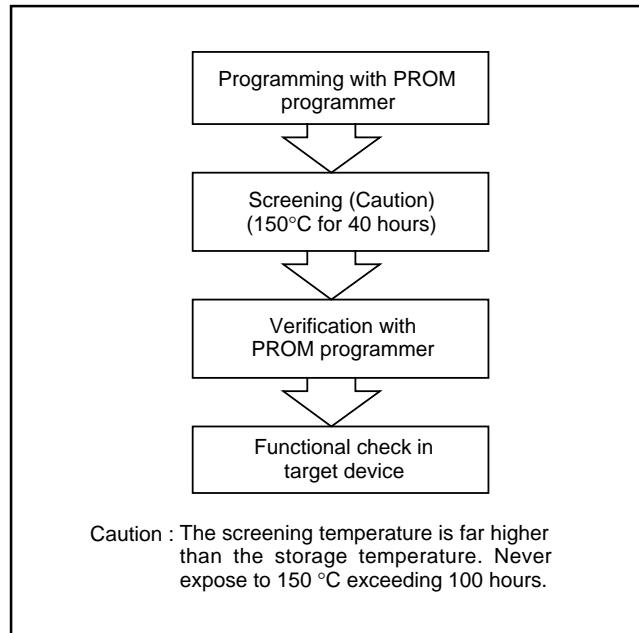


Fig. 31 Programming and testing of One Time PROM version

D-A CONVERTER CHARACTERISTICS(V_{CC} = 3.0 to 5.5 V, V_{SS} = AV_{SS} = 0 V, V_{REF} = 3.0 V to V_{CC}, T_a = -20 to 85 °C, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
—	Resolution				8	Bits
—	Absolute accuracy	V _{CC} = 4.0 to 5.5 V			1.0	%
		V _{CC} = 3.0 to 4.0 V			2.5	
t _{su}	Setting time				3	μs
R _O	Output resistor		1	2.5	4	kΩ
I _{VREF}	Reference power source input current (Note)				3.2	mA

Note: Using one D-A converter, with the value in the D-A conversion register of the other D-A converter being "0016", and excluding currents flowing through the A-D resistance ladder.

D-A CONVERTER CHARACTERISTICS (Extended operating temperature version)(V_{CC} = 4.0 to 5.5 V, V_{SS} = AV_{SS} = 0 V, V_{REF} = 3.0 V to V_{CC}, T_a = -40 to 85 °C, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
—	Resolution				8	Bits
—	Absolute accuracy				1.0	%
t _{su}	Setting time				3	μs
R _O	Output resistor		1	2.5	4	kΩ
I _{VREF}	Reference power source input current (Note)				3.2	mA

Note: Using one D-A converter, with the value in the D-A conversion register of the other D-A converter being "0016", and excluding currents flowing through the A-D resistance ladder.

D-A CONVERTER CHARACTERISTICS (High-speed version)

(VCC = 2.7 to 5.5 V, VSS = AVSS = 0 V, VREF = 2.7 V to VCC, Ta = -20 to 85 °C, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
—	Resolution				8	Bits
—	Absolute accuracy	Vcc = 4.0 to 5.5 V			1.0	%
		Vcc = 2.7 to 5.5 V			2.5	
tsu	Setting time				3	μs
Ro	Output resistor		1	2.5	4	kΩ
IVREF	Reference power source input current (Note)				3.2	mA

Note: Using one D-A converter, with the value in the D-A conversion register of the other D-A converter being "0016", and excluding currents flowing through the A-D resistance ladder.

SWITCHING CHARACTERISTICS 1 (High-speed version)

(VCC = 4.0 to 5.5 V, VSS = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
twH(SCLK1)	Serial I/O1 clock output "H" pulse width	Fig. 32	tc(SCLK1)/2-30			ns
twL(SCLK1)	Serial I/O1 clock output "L" pulse width		tc(SCLK1)/2-30			ns
td(SCLK1-TxD)	Serial I/O1 output delay time (Note 1)			140	ns	
tv(SCLK1-TxD)	Serial I/O1 output valid time (Note 1)		-30			ns
tr(SCLK1)	Serial I/O1 clock output rising time				30	ns
tf(SCLK1)	Serial I/O1 clock output falling time				30	ns
twH(SCLK2)	Serial I/O2 clock output "H" pulse width	Fig. 33	tc(SCLK2)/2-160			ns
twL(SCLK2)	Serial I/O2 clock output "L" pulse width		tc(SCLK2)/2-160			ns
td(SCLK2-SOUT2)	Serial I/O2 output delay time			200	ns	
tv(SCLK2-SOUT2)	Serial I/O2 output valid time		0			ns
tf(SCLK2)	Serial I/O2 clock output falling time				30	ns
tr(CMOS)	CMOS output rising time (Note 2)	Fig. 32		10	30	ns
tf(CMOS)	CMOS output falling time (Note 2)			10	30	ns

Note1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is "0".**2:** XOUT pin is excluded.**SWITCHING CHARACTERISTICS 2 (High-speed version)**

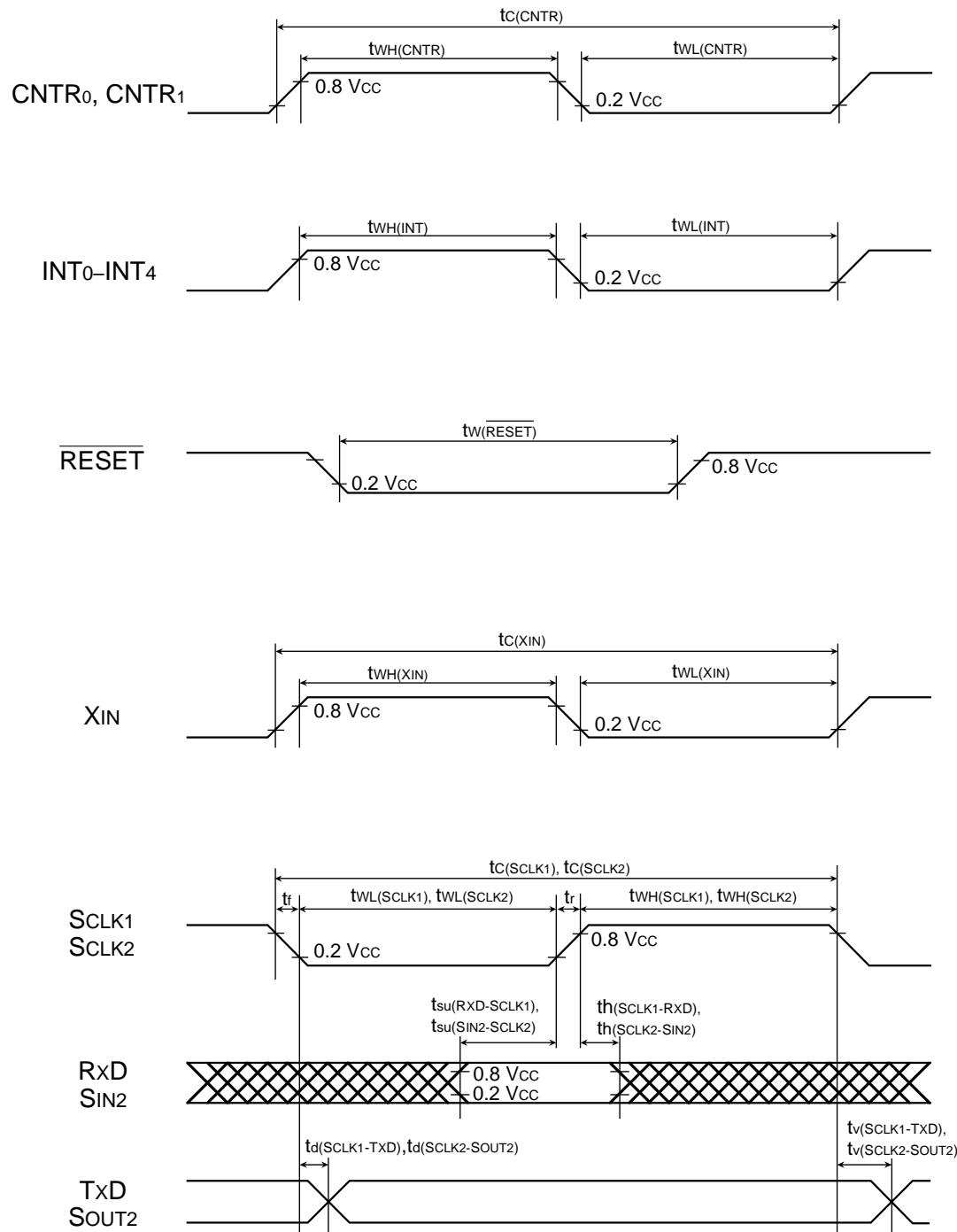
(VCC = 2.7 to 4.0 V, VSS = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
twH(SCLK1)	Serial I/O1 clock output "H" pulse width	Fig. 32	tc(SCLK1)/2-50			ns
twL(SCLK1)	Serial I/O1 clock output "L" pulse width		tc(SCLK1)/2-50			ns
td(SCLK1-TxD)	Serial I/O1 output delay time (Note 1)			350	ns	
tv(SCLK1-TxD)	Serial I/O1 output valid time (Note 1)		-30			ns
tr(SCLK1)	Serial I/O1 clock output rising time				50	ns
tf(SCLK1)	Serial I/O1 clock output falling time				50	ns
twH(SCLK2)	Serial I/O2 clock output "H" pulse width	Fig. 33	tc(SCLK2)/2-240			ns
twL(SCLK2)	Serial I/O2 clock output "L" pulse width		tc(SCLK2)/2-240			ns
td(SCLK2-SOUT2)	Serial I/O2 output delay time			400	ns	
tv(SCLK2-SOUT2)	Serial I/O2 output valid time		0			ns
tf(SCLK2)	Serial I/O2 clock output falling time				50	ns
tr(CMOS)	CMOS output rising time (Note 2)	Fig. 32		20	50	ns
tf(CMOS)	CMOS output falling time (Note 2)			20	50	ns

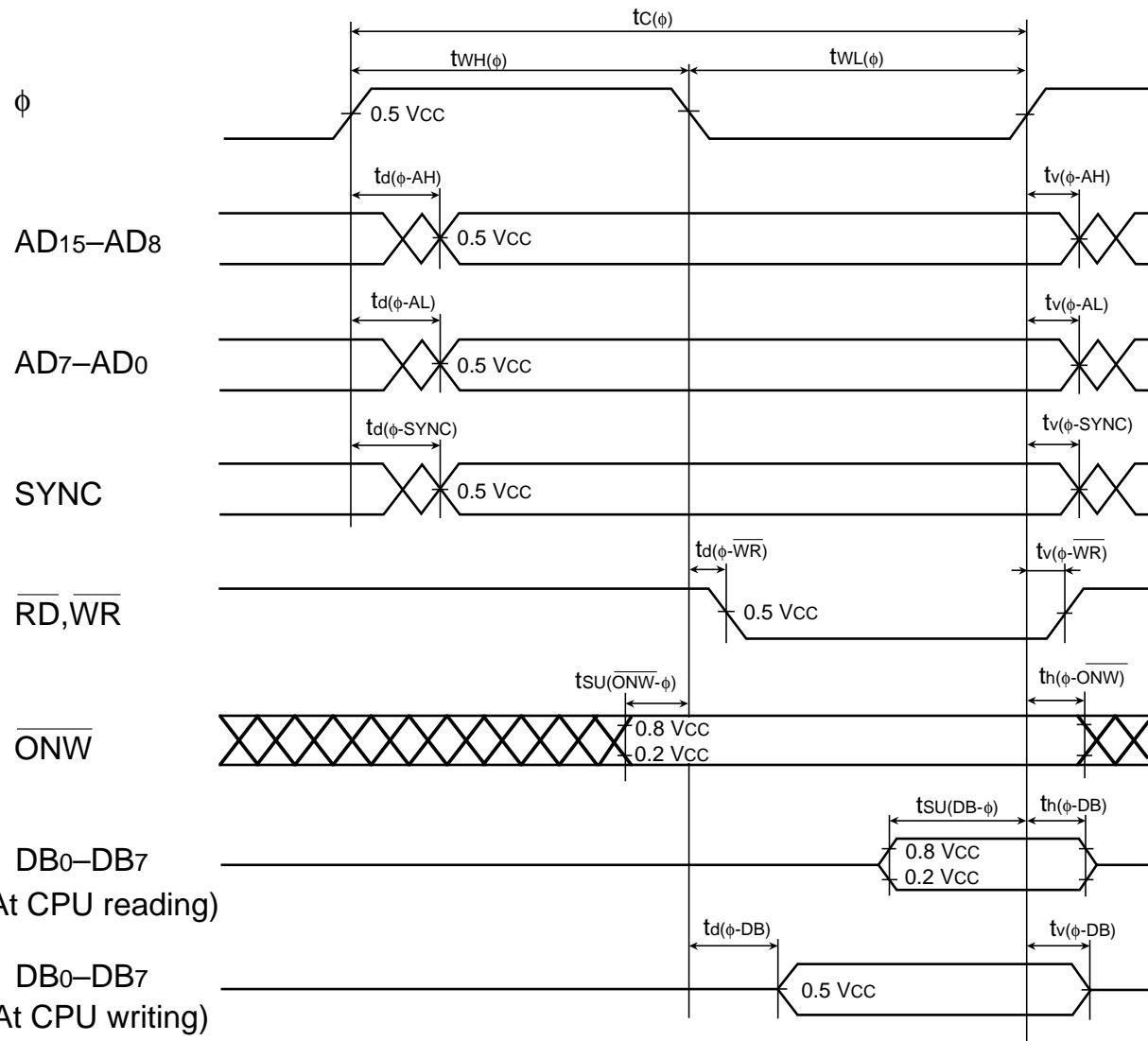
Note 1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is "0".**2:** XOUT pin is excluded.

TIMING DIAGRAM

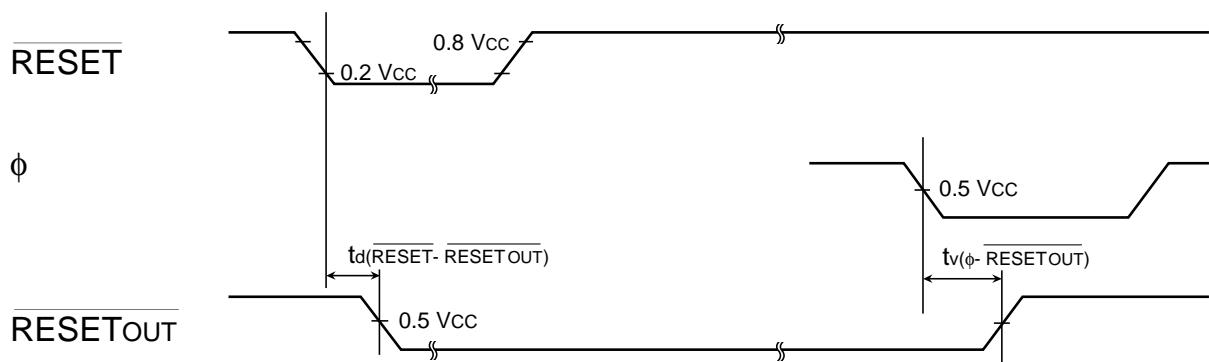
(1) Timing Diagram



(2)Timing Diagram in Memory Expansion Mode and Microprocessor Mode (a)

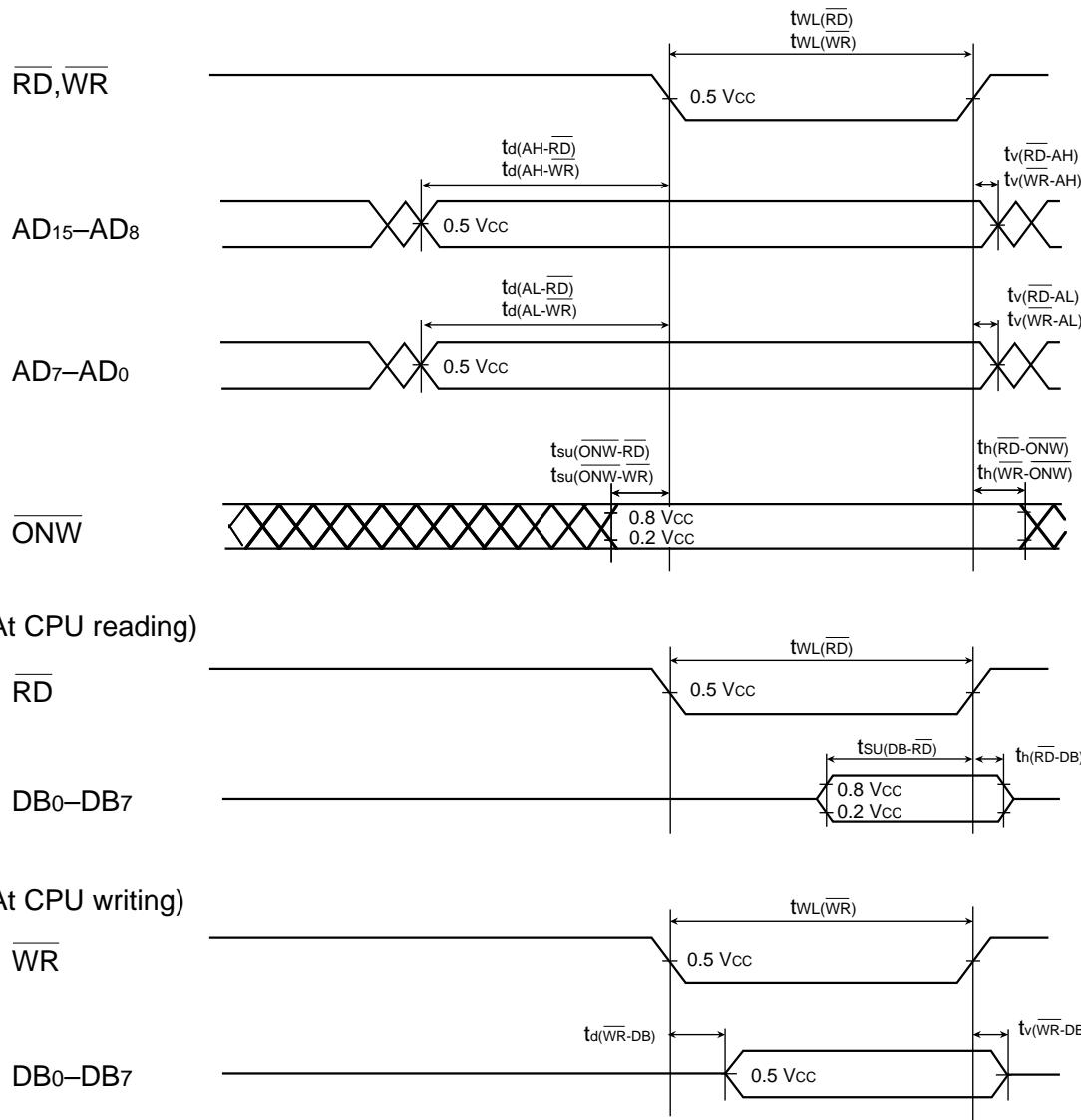


(3)Timing Diagram in Microprocessor Mode



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(4) Timing Diagram in Memory Expansion Mode and Microprocessor Mode (b)



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

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